

Unified Regional Charge-based Versus Surface-potential-based Compact Modeling Approaches

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May 10, 2005

Presentation Outline

- **Charge modeling:** Pao–Sah surface-potential solutions
- **Unified regional approach**
 - ❑ Piecewise/regional and non-pinned surface potential
 - ❑ Unified regional charge model
 - ❑ Charge-based bias-scalable transcapacitances and symmetry
 - ❑ Poly-accumulation/depletion/inversion effects
 - ❑ Coupled quantum-mechanical effect with PAE/PDE
 - ❑ Extension to strained-Si MOSFET charge modeling
 - ❑ One/two-iteration AC model parameter extraction
- **DC model calibration and prediction**
 - ❑ Minimum data for model calibration
 - ❑ One-iteration parameter extraction
- **Summary and conclusions**

Comparison of Modeling Approaches

Surface-potential (ϕ_s) based

Iterative

MM11

HiSIM

+

Explicit

SP

= PSP

(Accurate physics built-in for all regions, inherent requirement of high ϕ_s accuracy)

(Inversion)-charge (Q_i) based

EKV

ACM

BSIM5

(Not as accurate but less demanding on high ϕ_s accuracy; still need ϕ_s solutions in extrinsic and accumulation)

Threshold-voltage (V_t) based

(Pinned surface potential)

BSIM3,4

MM9

(Less physical in strong inversion)

Unified, single-piece, explicit **regional charge-based** model with **non-pinned surface potential**

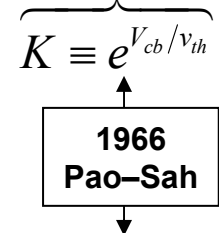
Xsim: unique features — combining “accurate” physics in **surface potential** solutions with unified “smooth” **regional charges** without losing the “process-dependent” **threshold voltage** concept

- Do not solve at $V_{gb} = V_{fb}$, but two regional pieces unified to form a *single-piece* with C_∞ continuity (no ‘if’ conditionals anywhere)
- Do not require high accuracy in ϕ_s since charges ($V_{ds} = 0$) do not depend on $\phi_{s0} - \phi_{sL}$
- ❖ Consistent with conventional formulations
- ❖ Easy extension to include higher-order effects (QM, poly-doping, strained-Si, 2D SCEs, ...)

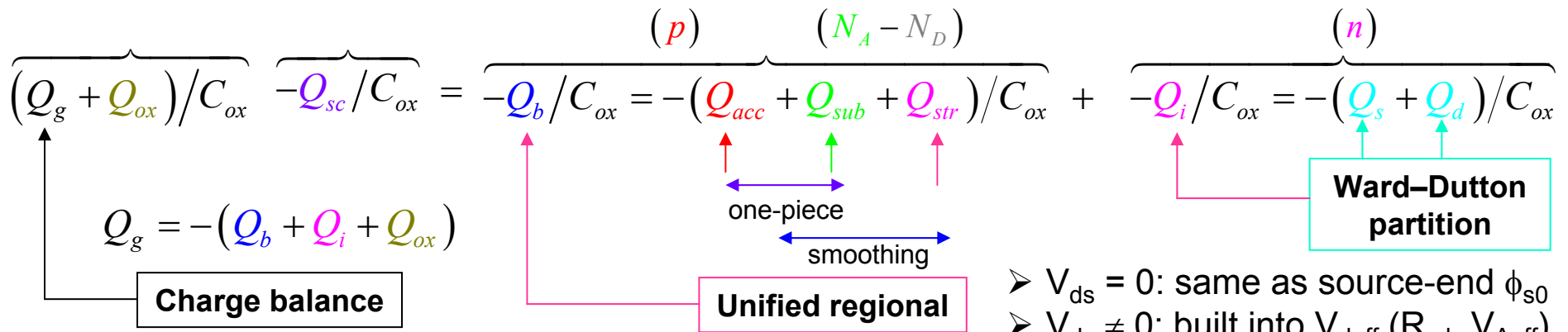
The Complete Potential/Charge Balance (“Pao–Sah”)

$$F \equiv V_{gb} - V_{fb} - \phi_s = \text{sgn}(\phi_s) \gamma \sqrt{v_{th}} \left[\exp\left(-\frac{\phi_s}{v_{th}}\right) - 1 + \frac{\phi_s}{v_{th}} \right] + v_{th} \exp\left(-\frac{V_{cb} + 2\phi_F}{v_{th}}\right) \left[\exp\left(\frac{\phi_s}{v_{th}}\right) - 1 - \frac{\phi_s}{v_{th}} \exp\left(\frac{V_{cb}}{v_{th}}\right) \right]$$

$$K \begin{cases} = e^{V_{cb}/v_{th}} & \text{Original Pao–Sah: negative } F^2 \text{ for small positive } \phi_s \text{ (when } V_{cb} > 0) \\ = 0 & \text{Modified Pao–Sah: negative } F^2 \text{ for small negative } \phi_s \text{ (when } V_{cb} > 0) \\ = 1 & \text{Modified Pao–Sah: no negative } F^2 \text{ (used in iterative/explicit solutions)} \end{cases}$$

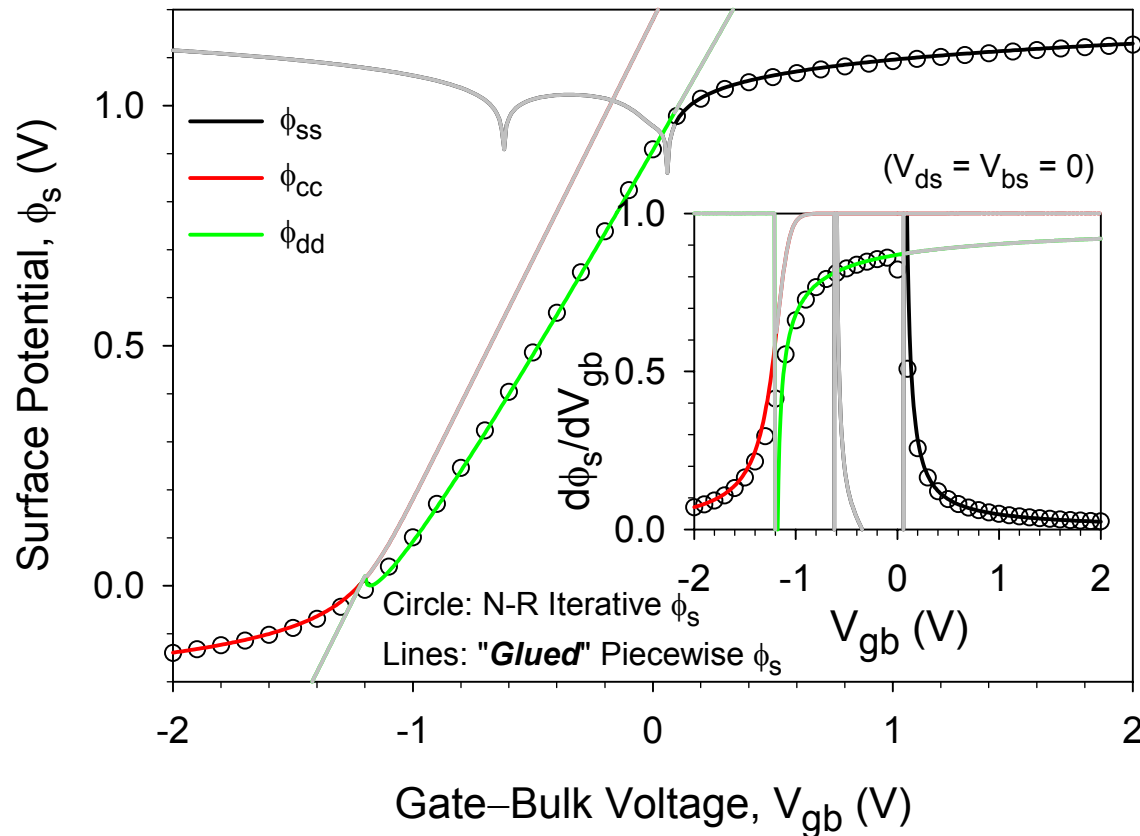


$$V_{gb} - V_{fb} - \phi_s = \text{sgn}(\phi_s) \gamma \sqrt{f_\phi} = \pm \gamma \sqrt{v_{th}} \left[\exp\left(-\frac{\phi_s}{v_{th}}\right) - 1 \right] + \phi_s - \phi_s \exp\left(-\frac{2\phi_F}{v_{th}}\right) + v_{th} \exp\left(-\frac{V_{cb} + 2\phi_F}{v_{th}}\right) \left[\exp\left(\frac{\phi_s}{v_{th}}\right) - 1 \right]$$



- $V_{ds} = 0$: same as source-end ϕ_{s0}
- $V_{ds} \neq 0$: built into V_{deff} (R_{sd} , V_{Aeff})

“Glued” Piecewise Regional ϕ_s Solutions



- Simple piecewise regional ϕ_s solutions:

$$\phi_{ss} = \phi_B + \Delta$$

$$\phi_{cc} = V_{gb} - V_{fb} + 2v_{th}\mathcal{L}\{w\}$$

$$\phi_{dd} = \left(-\frac{\gamma}{2} + \sqrt{\frac{\gamma^2}{4} + V_{gb} - V_{fb}} \right)^2$$

- When “glued” together, *glitches* at flat-band (V_{fb} , $\phi_s = 0$) and threshold (V_t , $\phi_s = 2\phi_F$) conditions
- Even with careful math for explicit solution, *ripple* may occur when solution pieces are “glued”

Piecewise and Unified Regional Pao–Sah Solutions

$$V_{gb} - V_{fb} - \phi_B = \gamma \sqrt{\phi_B + v_{th} + v_{th} \exp\left(-\frac{V_{cb} + 2\phi_F}{v_{th}}\right) \exp\left(\frac{\phi_s}{v_{th}}\right)}$$

$$\phi_B = 2\phi_F + V_{cb} \longrightarrow \phi_{ss} = \phi_B + \Delta \longrightarrow \phi_{str}$$

$$\Delta = v_{th} \ln \left\{ \frac{1}{v_{th}} \left[\left(\frac{V_{gb} - V_{fb} - \phi_{ss}^*}{\gamma} \right)^2 - (\phi_{s0} + V_{cb}) \right] + 1 \right\}$$

$$\phi_{ss}^* = \phi_{s0} + V_{cb} + \frac{\phi_{dd} - (\phi_{s0} + V_{cb})}{\sqrt{1 + \left[\frac{\phi_{dd} - (\phi_{s0} + V_{cb})}{4v_{th}} \right]^2}}$$

$$\phi_{seff} = \phi_{acc} + \phi_{ds}$$

$$V_{gb} - V_{fb} - \phi_s = \gamma \sqrt{\phi_s}$$

$$\phi_{ds} = \mathcal{G}_{eff} \{ \phi_{sub}, \phi_{str}; \delta_\phi \}$$

$$\phi_{dd} = \left(-\frac{\gamma}{2} + \sqrt{\frac{\gamma^2}{4} + V_{gb} - V_{fb}} \right)^2$$

$$V_{gb} - V_{fb} \rightarrow V_{gbf}$$

$$\phi_{sub}$$

$$\Delta = v_{th} \ln \{ b_{eff} \}$$

$$b_{eff} = \frac{1}{v_{th}} \mathcal{G}_f \left\{ \left(\frac{V_{ga}}{\gamma} \right)^2 - (\phi_{s0} + V_{cb}); \sigma_{eff} \right\} + 1$$

$$V_{gb} - V_{fb} - \phi_s = -\gamma \sqrt{v_{th} \exp\left(-\frac{\phi_s}{v_{th}}\right)}$$

$$\phi_{sa} = \phi_{acc} + \phi_{sub}$$

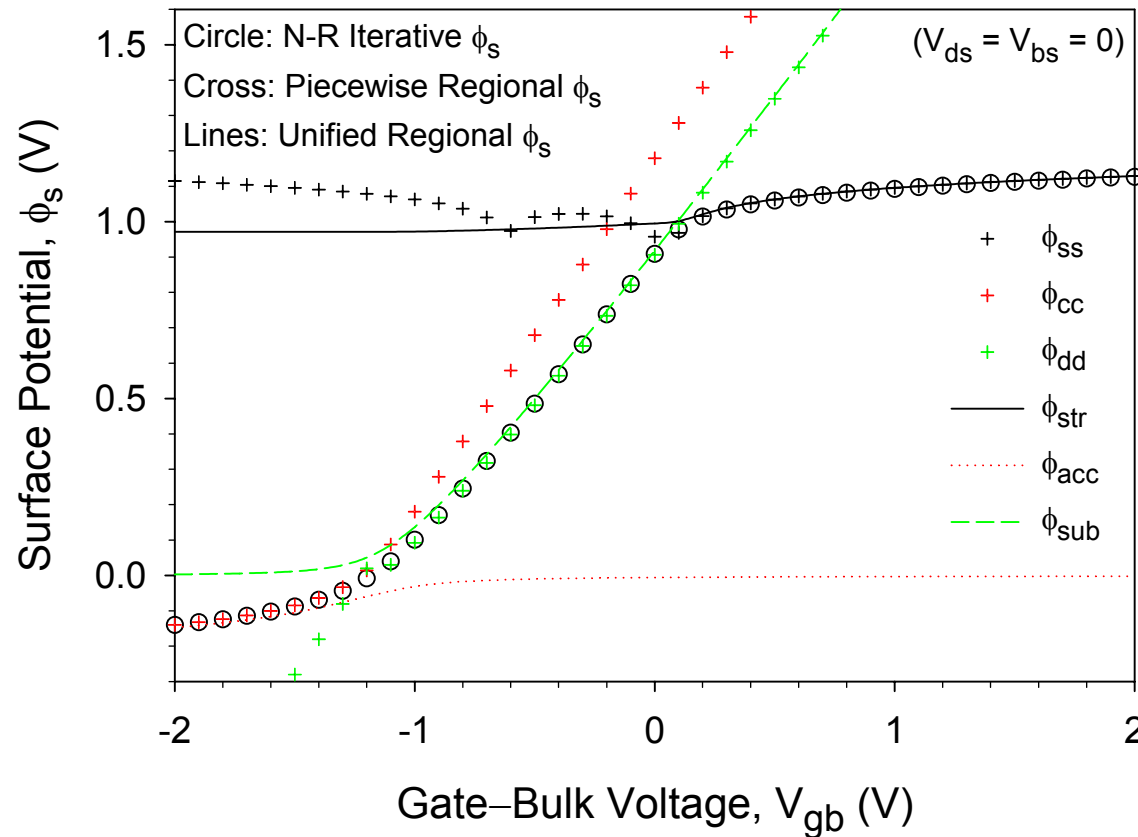
$$V_{ga} = \mathcal{G}_f \{ V_{gb} - V_{fb} - \phi_{str}^*; \sigma_{vga} \}$$

$$\phi_{cc} = V_{gb} - V_{fb} + 2v_{th} \mathcal{L} \{ w \} \xrightarrow{V_{gb} - V_{fb} \rightarrow V_{gbr}} \phi_{acc}$$

$$\mathcal{G}_f \{ x; \sigma \} \equiv 0.5 \left(x + \sqrt{x^2 + 4\sigma} \right)$$

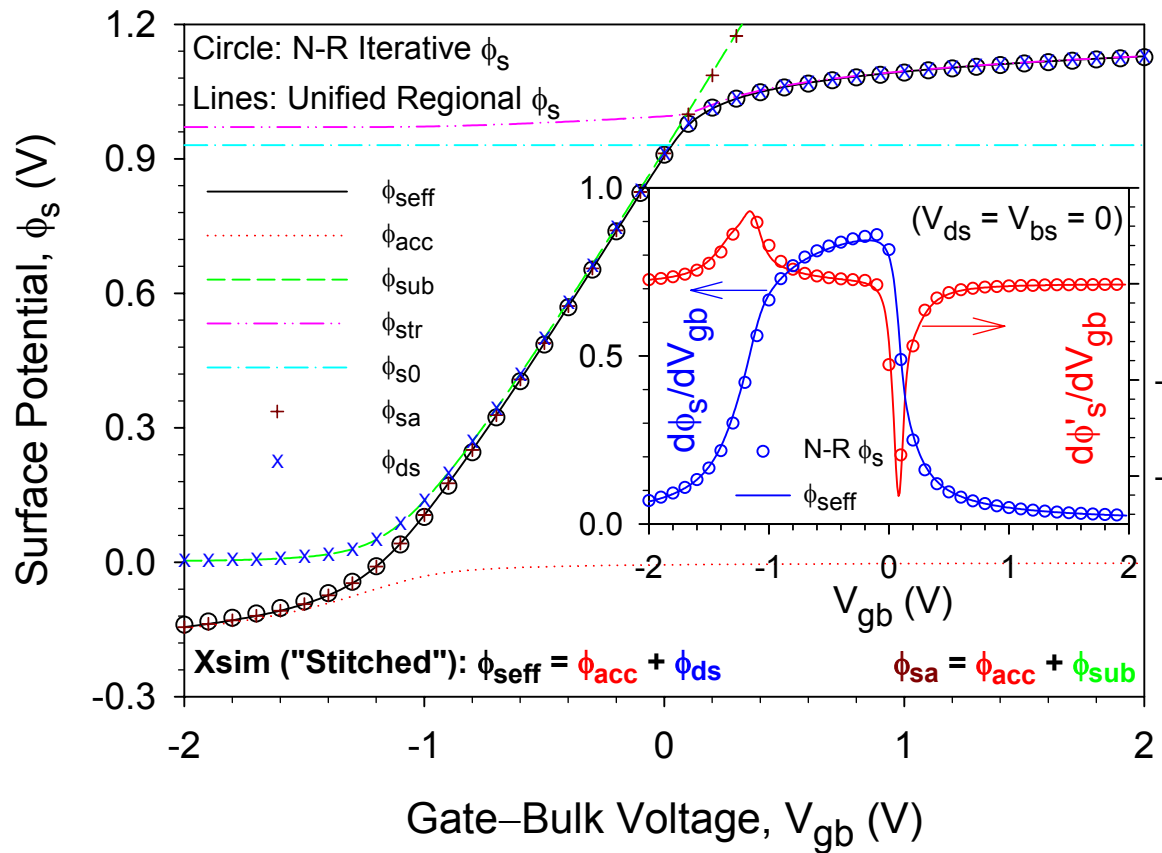
$$\mathcal{G}_r \{ x; \sigma \} \equiv -0.5 \left(-x + \sqrt{x^2 + 4\sigma} \right)$$

Piecewise and Unified Regional ϕ_s Solutions



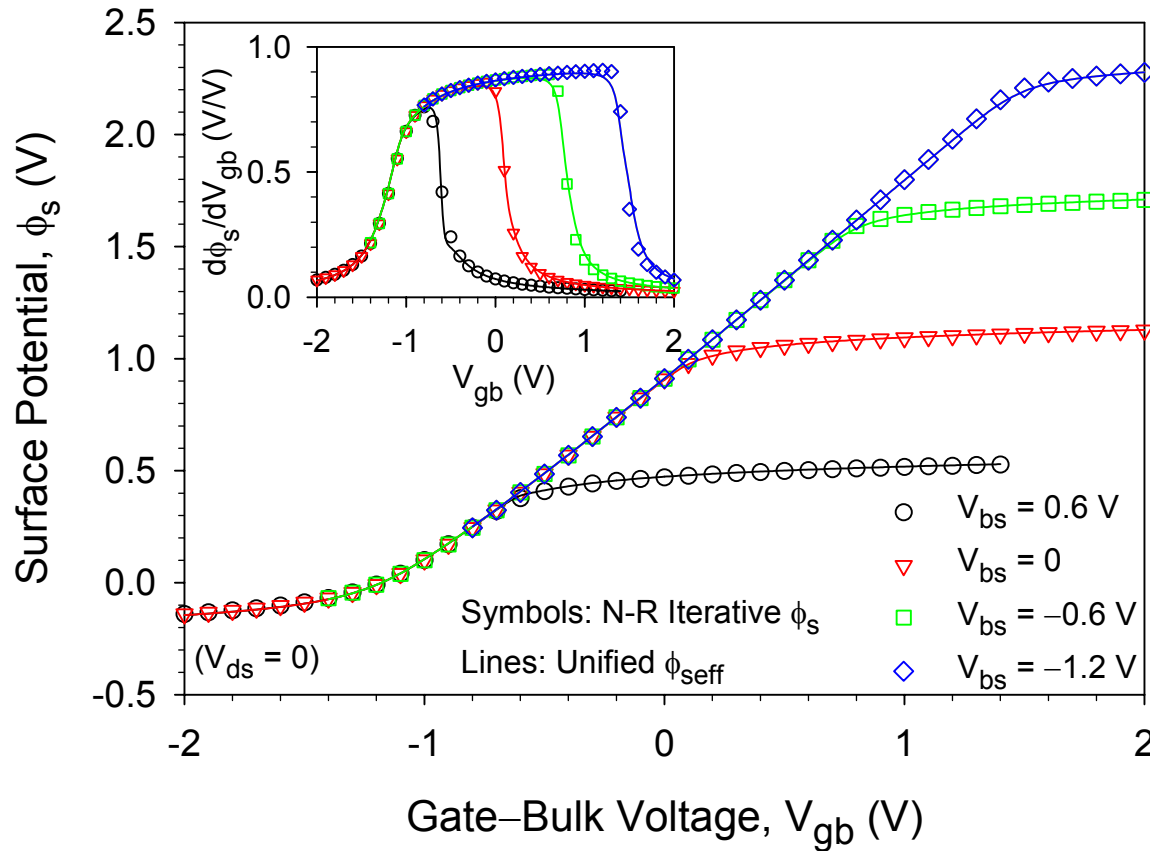
- Piecewise regional solutions are derived physically
- Unified regional solutions approach the respective physical solutions asymptotically
- Transition regions are “controlled” by the smoothing parameters, whose values do not influence asymptotic solutions

Unified ϕ_s Solutions and Continuity



- ϕ_s at $V_{gb} = V_{fb}$ is not solved exactly, but two pieces "**stitched**" to form a single-piece (ϕ_{seff}) seamlessly
- ϕ_{seff} solution can be arbitrarily close to V_{fb} without any 'if' conditionals, with C_∞ continuity
- ϕ_{acc} and ϕ_{sub} are independent of V_{ds} ; ϕ_{str} evaluated at the source/drain ends, keeping symmetry

Single-piece Unified ϕ_{seff} and ϕ'_{seff} in *All* Regions



- Single-piece ϕ_{seff} in all bias regions, including forward bulk bias
- Not directly used in charge formulations; only the regional solutions are used in the *unified regional charge model*

Unified Charge Model with Non-pinned Surface Potential

$$\int \downarrow \boxed{Q_i(y) = -C_{ox} [V_{gb} - V_{fb} - \psi_s(y)] - Q_b(y)} \quad \text{[Ward \& Dutton]}$$

$$\boxed{Q_i = Q_s + Q_d}$$

Piecewise regional:

Unified regional (pinned, no 'Δ'):

Non-pinned:

$$Q_s = -C_{ox} \left(\frac{V_{gs} - V_t}{2} - \frac{A_b}{6} V_{ds} + A_s \right)$$

$$Q_d = -C_{ox} \left(\frac{V_{gs} - V_t}{2} - \frac{A_b}{3} V_{ds} + A_d \right)$$

$$A_s = \mathcal{A}(1 - \mathcal{B})$$

$$A_d = \mathcal{A}\mathcal{B}$$

$$D_b = (A_b - 1)V_{ds}\mathcal{D}$$

$$\mathcal{A} = \frac{A_b^2 V_{ds}^2}{12(V_{gs} - V_t - 0.5A_b V_{ds})}$$

$$\mathcal{B} = \frac{5(V_{gs} - V_t) - 2A_b V_{ds}}{10(V_{gs} - V_t - 0.5A_b V_{ds})}$$

$$\mathcal{D} = \frac{3(V_{gs} - V_t) - 2A_b V_{ds}}{6(V_{gs} - V_t - 0.5A_b V_{ds})}$$

$$\boxed{Q_{s,\Delta} = -C_{ox} \left(\frac{V_{gt,\phi}}{2} - \frac{A_{b,\Delta}}{6} V_{deff,\Delta} + A_{s,\Delta} \right)}$$

$$\boxed{Q_{d,\Delta} = -C_{ox} \left(\frac{V_{gt,\phi}}{2} - \frac{A_{b,\Delta}}{3} V_{deff,\Delta} + A_{d,\Delta} \right)}$$

$$\mathcal{A}_{eff,\Delta} = \frac{A_{b,\Delta}^2 V_{deff,\Delta}^2}{12(V_{geff,\Delta} - 1/2 A_{b,\Delta} V_{deff,\Delta})}$$

$$\mathcal{B}_{eff,\Delta} = \frac{5V_{geff,\Delta} - 2A_{b,\Delta} V_{deff,\Delta}}{10(V_{geff,\Delta} - 1/2 A_{b,\Delta} V_{deff,\Delta})}$$

$$A_{s,\Delta} = \mathcal{A}_{eff,\Delta} (1 - \mathcal{B}_{eff,\Delta}) \quad A_{d,\Delta} = \mathcal{A}_{eff,\Delta} \mathcal{B}_{eff,\Delta}$$

(Derived from 'pinned' I_{ds})

$$V_{t,\Delta} = V_t + A_b \Delta_{eff,s}$$

$$V_{deff,\Delta} = V_{deff} + \Delta_{ds}$$

$$V_{geff,\Delta} = V_{geff}(V_{t,\phi})$$

$$A_{b,\Delta} = 1 + \frac{\gamma}{2\sqrt{\phi_{s0} + \Delta_{eff,s} - V_{bs}}}$$

$$V_{t,\phi} = V_{FB} + \phi_{str,s} + \gamma\sqrt{\phi_{str,s}} + V_{bs}$$

$$V_{gt,\phi} = nv_{th} \ln\left(1 + e^{(V_{gs} - V_{t,\phi})/(nv_{th})}\right)$$

$$D_{b,\Delta} = (A_{b,\Delta} - 1)V_{deff,\Delta}\mathcal{D}_{eff,\Delta}$$

Unified Regional Bulk-Charge Modeling

$$\boxed{-(V_{gb} - V_{fb} - \phi_s) = -(Q_g + Q_{ox}) \approx -Q_g} = \boxed{Q_{sc}} = \boxed{Q_b \approx Q_b + Q_i = -\text{sgn}(\phi_s) C_{ox} \sqrt{f_\phi}}$$

$$V_{gb} - V_{fb} \equiv V_{gba}(\sigma_a) + V_{gbr}(\sigma_a)$$

$$Q_{b,sa} = Q_{sc} = -C_{ox}(V_{gb} - V_{fb} - \phi_{sa})$$

$$= -C_{ox} \left[(V_{gba} + V_{gbr}) - (\phi_{acc} + \phi_{sub}) \right]$$

$$= -C_{ox} \left[(V_{gbr} - \phi_{acc}) + (V_{gba} - \phi_{sub}) + (V_{gbf} - V_{gbf}) \right]$$

$$= -C_{ox} \left[(V_{gbr} - \phi_{acc}) + (V_{gba} - V_{gbf}) + (V_{gbf} - \phi_{sub}) \right]$$

$$= Q_{b,acc} + Q_{b,sub}$$

$$\phi_{sa} = \phi_{acc} + \phi_{sub}$$

$$V_{gbf} = \mathcal{G}_f \{ V_{gb} - V_{fb}; \sigma_f \}$$

$$V_{gbr} = \mathcal{G}_r \{ V_{gb} - V_{fb}; \sigma_a \}$$

$$V_{gba} = \mathcal{G}_f \{ V_{gb} - V_{fb}; \sigma_a \}$$

$$Q_{b,sub}^* \equiv -C_{ox}(V_{gbf} - \phi_{sub}) = -\gamma C_{ox} \sqrt{\phi_{sub}}$$

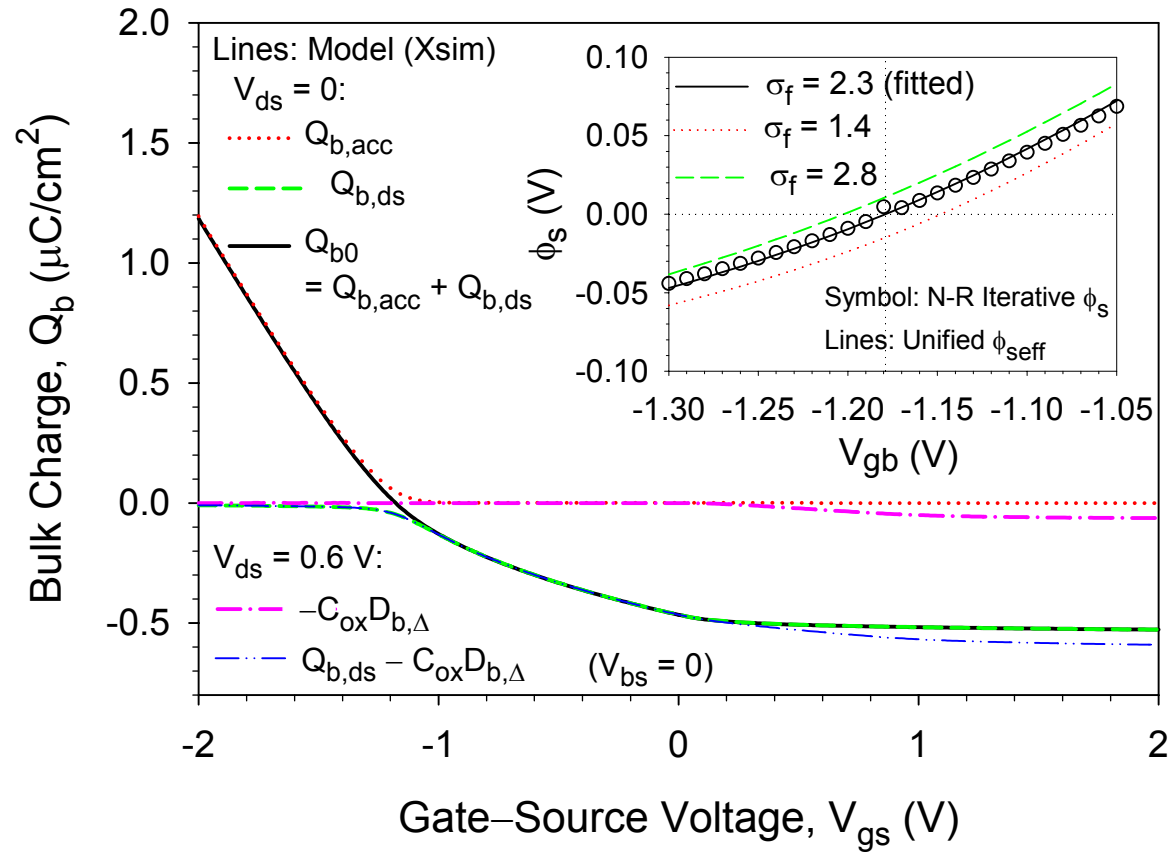
$$Q_{b,acc} \equiv -C_{ox}(V_{gbr} - \phi_{acc})$$

$$Q_{b,sub} \equiv -C_{ox}(V_{gba} - V_{gbf} + \gamma \sqrt{\phi_{sub}}) \longrightarrow Q_{b,ds} = -C_{ox}(V_{gba} - V_{gbf} + \gamma \sqrt{\phi_{ds,s}})$$

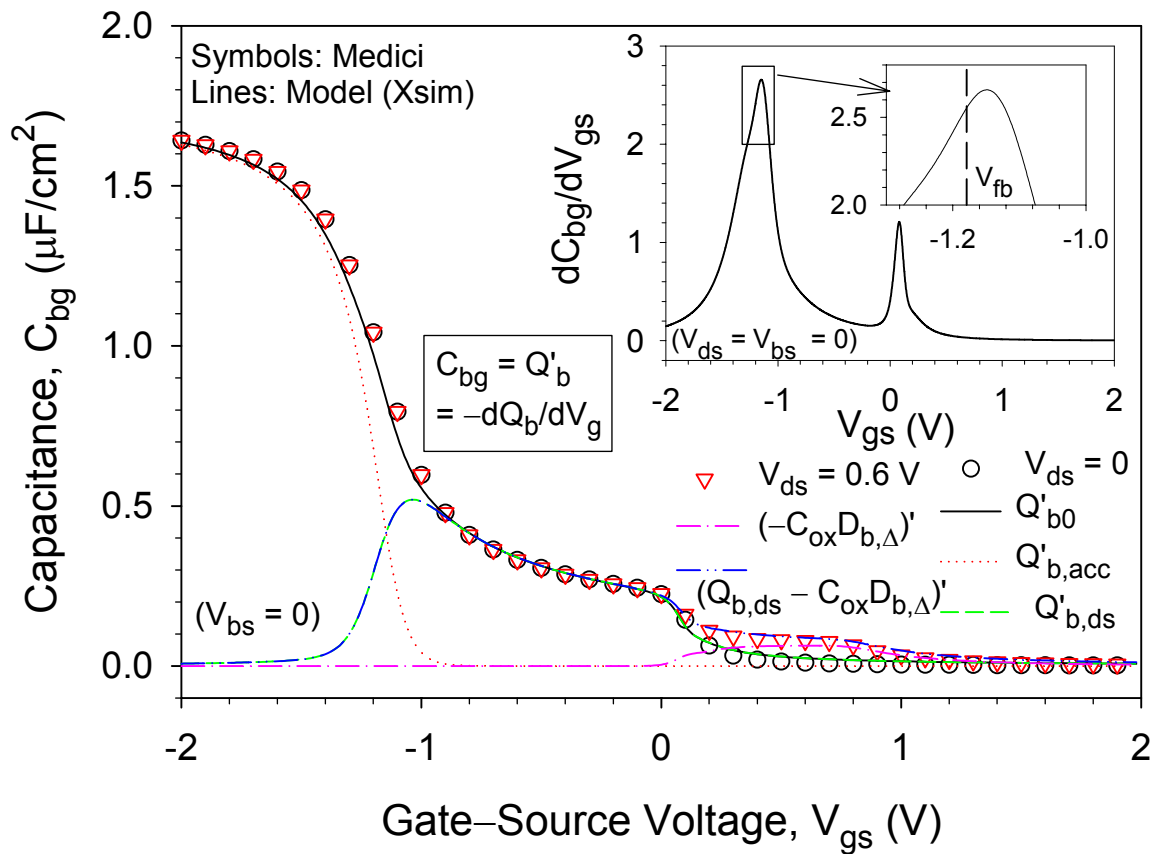
$$\boxed{Q_{b0} = Q_{b,acc} + Q_{b,ds}}$$

$$\boxed{Q_b = Q_{b0} - C_{ox} D_{b,\Delta}}$$

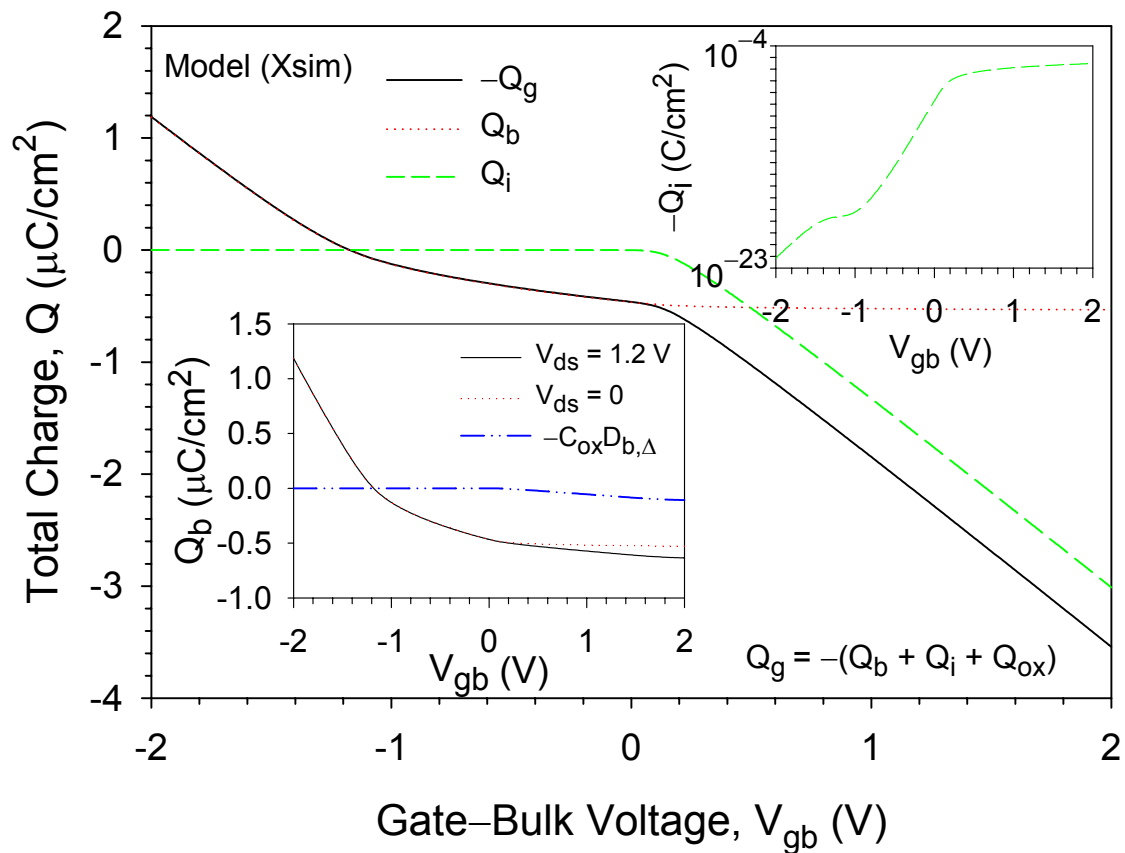
Unified Regional Bulk Charge and Charge Neutrality



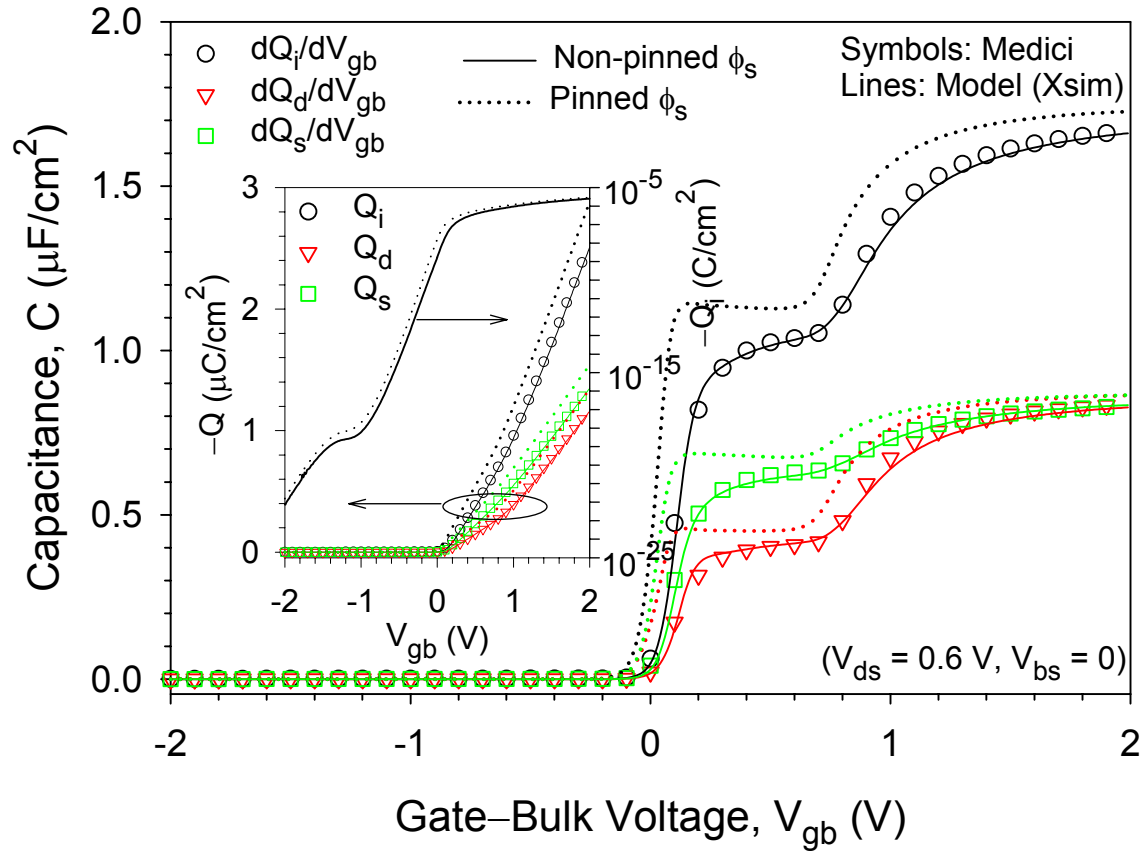
“Decomposable” Bulk Capacitance with Continuity



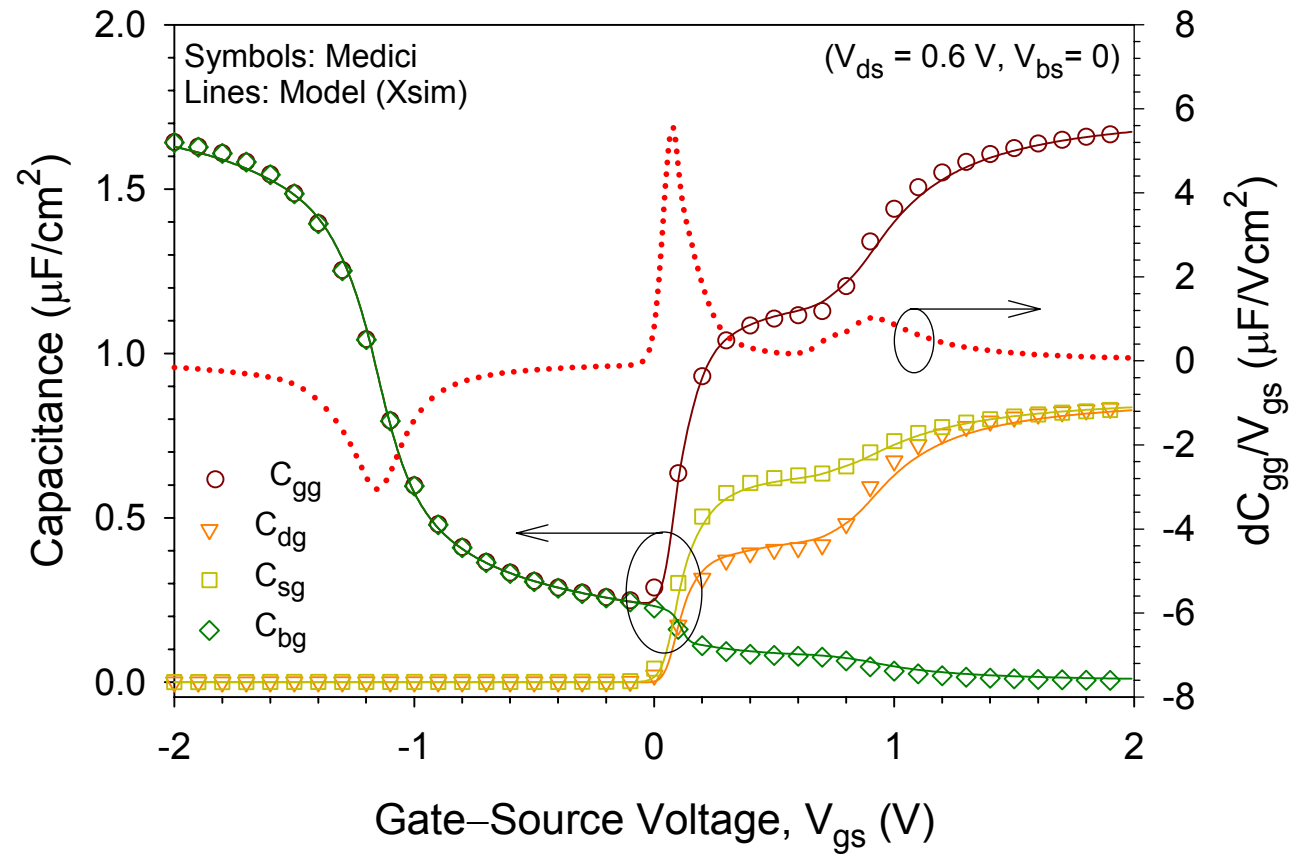
Single-piece Terminal Charges



Inversion Charges and Capacitances with Non-pinned ϕ_s



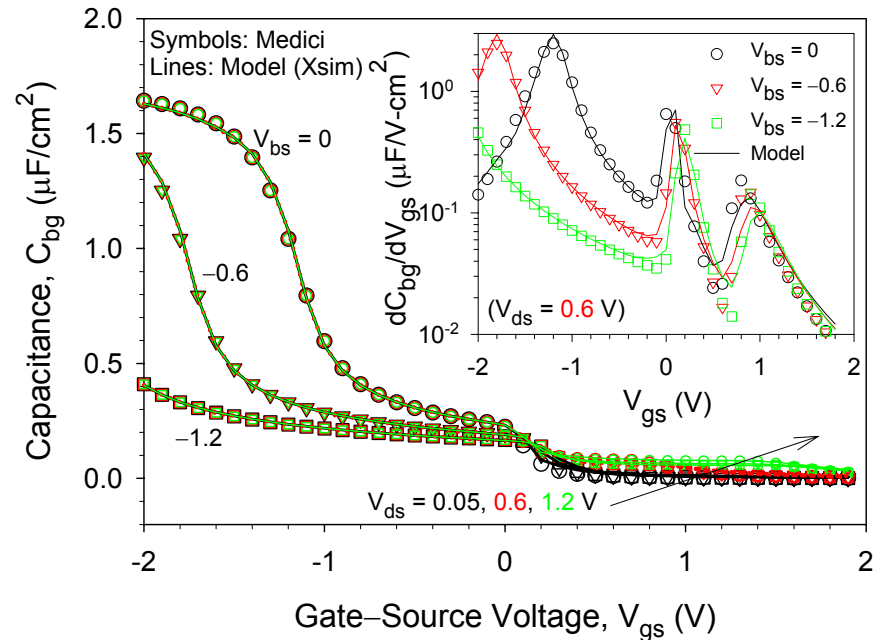
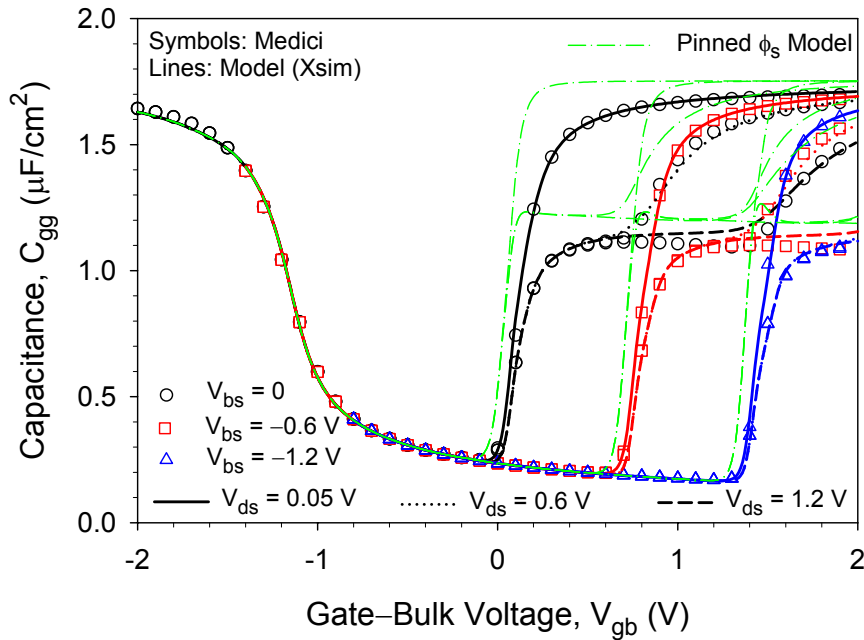
Transcapacitance and Charge Conservation



Single-piece Continuous C_{gg} , C_{bg} and C'_{bg} in *All* Regions

C_{gg} at various V_{ds} , V_{bs}
(Compared with pinned ϕ_s)

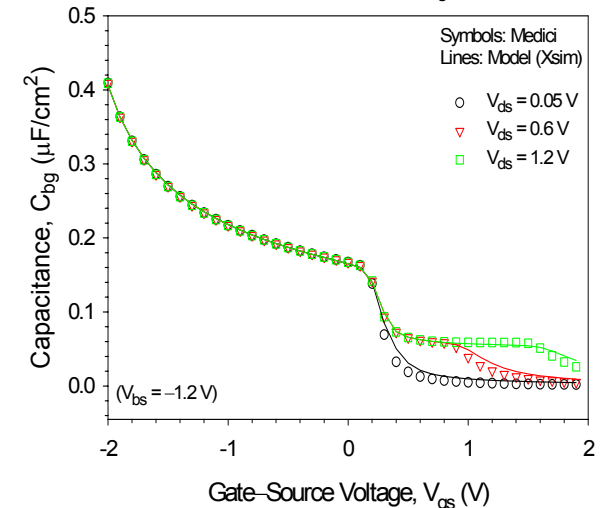
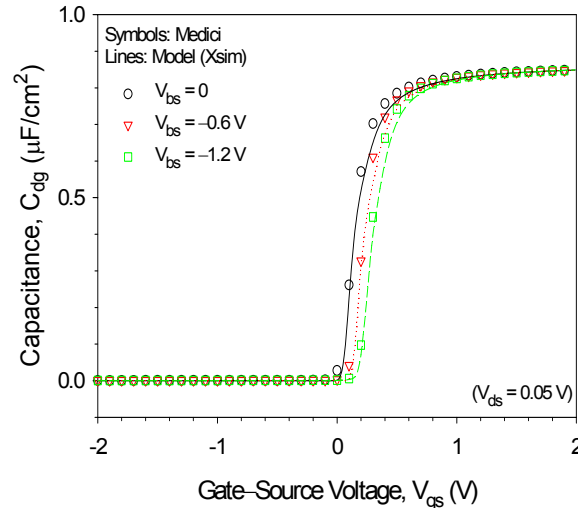
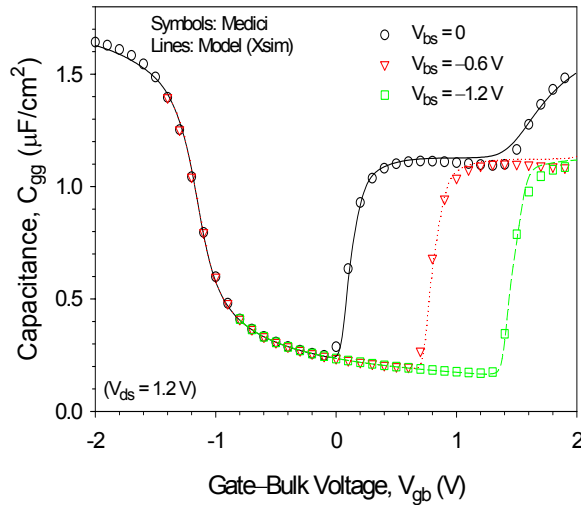
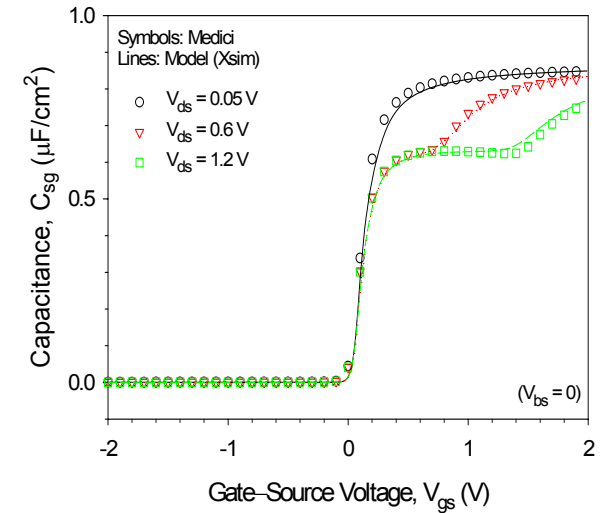
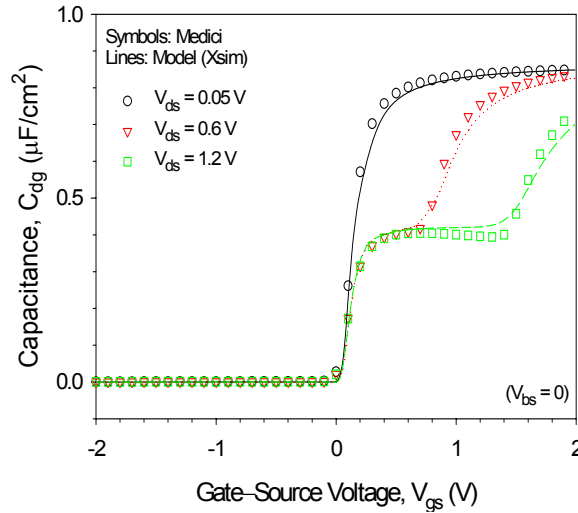
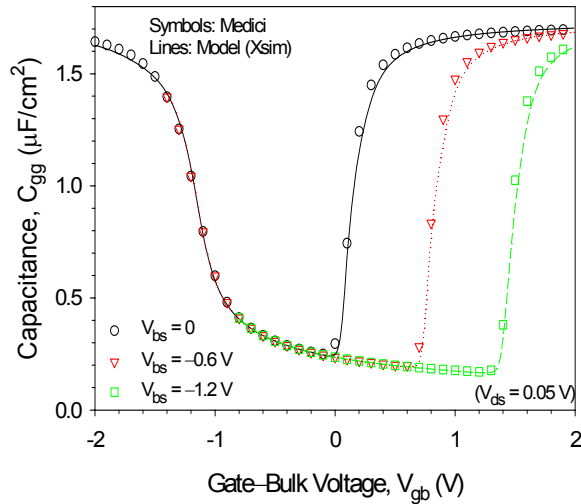
C_{bg} at various V_{ds} , V_{bs}
(Compared with Medici C'_{bg})



Bias-scalable C_{gg} , C_{dg} , C_{sg} , C_{bg} in *All* Regions

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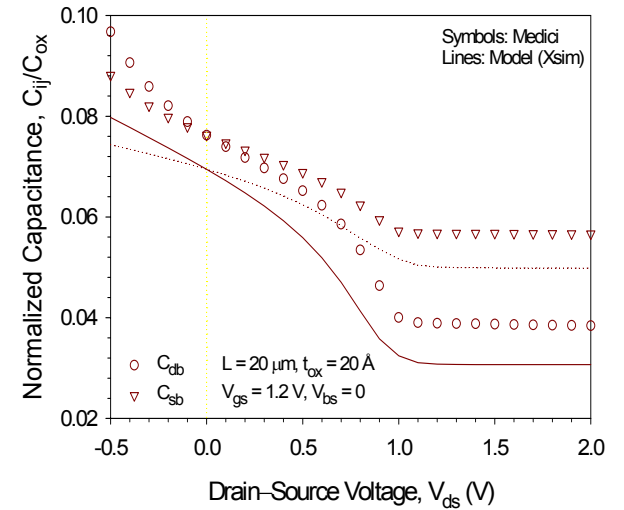
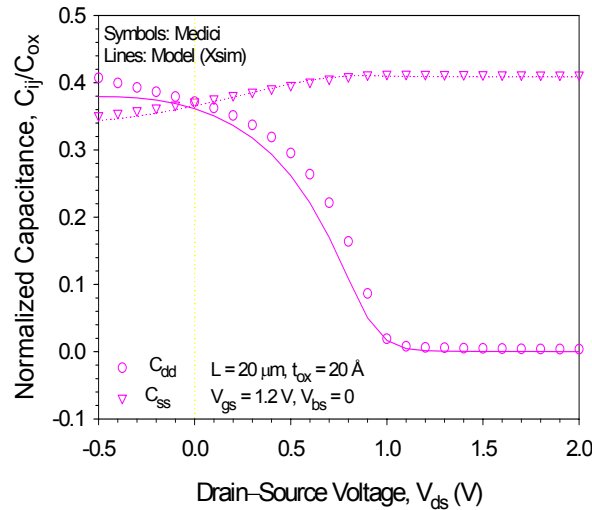
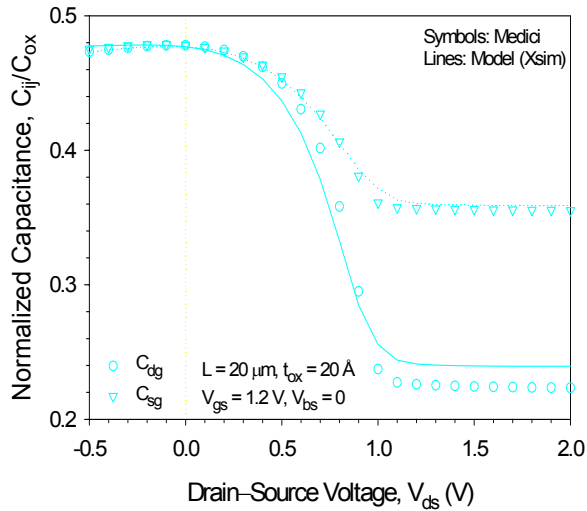
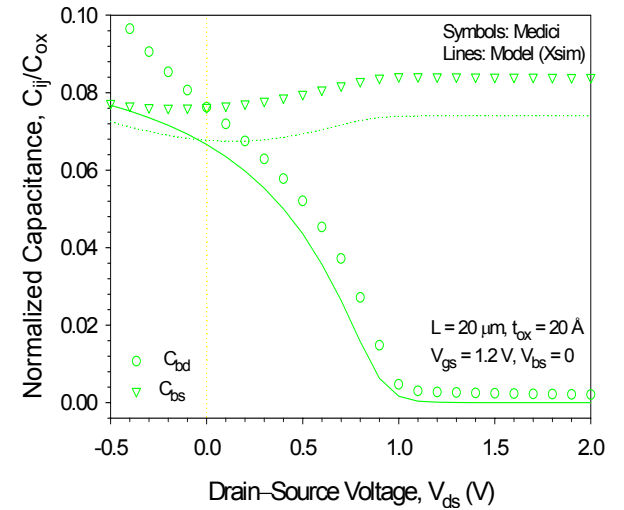
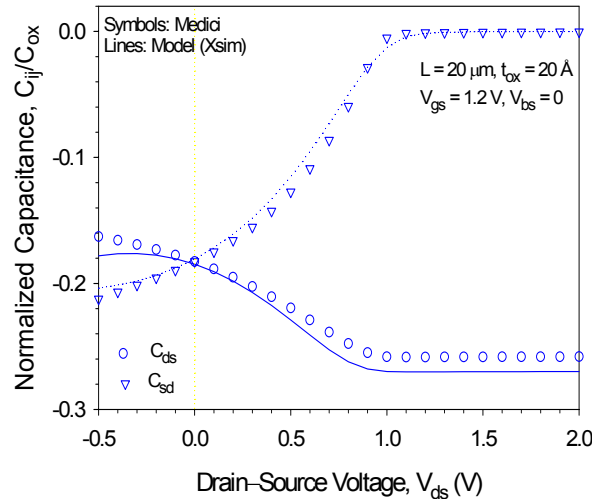
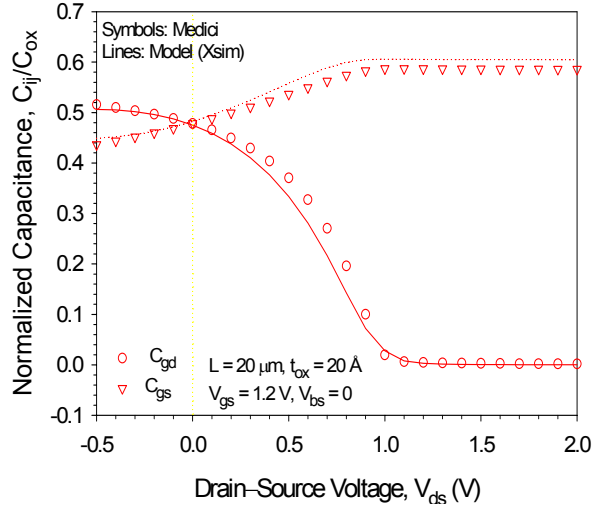
MSM / Nanotech



Transcapacitance Symmetry

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“Pao–Sah” Equation for the Gate Surface Potential ϕ_p

$$\begin{aligned} \overline{V_{gb} - V_{fb} - \phi_s - \phi_p} &= \text{sgn}(\phi_p) \gamma_p \sqrt{f_{\phi,p}} \\ &= \pm \gamma_p \sqrt{v_{th} \left[\exp\left(-\frac{\phi_p}{v_{th}}\right) - 1 \right] + \phi_p - \phi_p \exp\left(-\frac{2\phi_{F,p}}{v_{th}}\right) + v_{th} \exp\left(-\frac{2\phi_{F,p}}{v_{th}}\right) \left[\exp\left(\frac{\phi_p}{v_{th}}\right) - 1 \right]} \end{aligned} \quad (V_{cb} = 0)$$

$$\phi_{p,ss} = \phi_{p0} + \Delta_p \longrightarrow \boxed{\phi_{p,str}}$$

$$\phi_{p,ss}^* = \phi_{p0} + \frac{\phi_{p,dd} - \phi_{p0}}{\sqrt{1 + \left[\frac{\phi_{p,dd} - \phi_{p0}}{4v_{th}} \right]^2}}$$

$$\Delta_p = v_{th} \ln \left\{ \frac{1}{v_{th}} \mathcal{G}_f \left\{ \left(\frac{V_{gap}}{\gamma_p} \right)^2 - \phi_{p0}; \rho_{eff} \right\} + 1 \right\}$$

$$V_{gap} = \mathcal{G}_f \{ V_{gb} - V_{fb} - \phi_s - \phi_{p,str}^*; \rho_{vga} \}$$

Coupling to ϕ_s :
 $\phi_s = \phi_{seff}$ in ϕ_{peff}
 $\overline{V_{gb} - V_{fb} - \phi_{peff}}$ in ϕ_{seff}

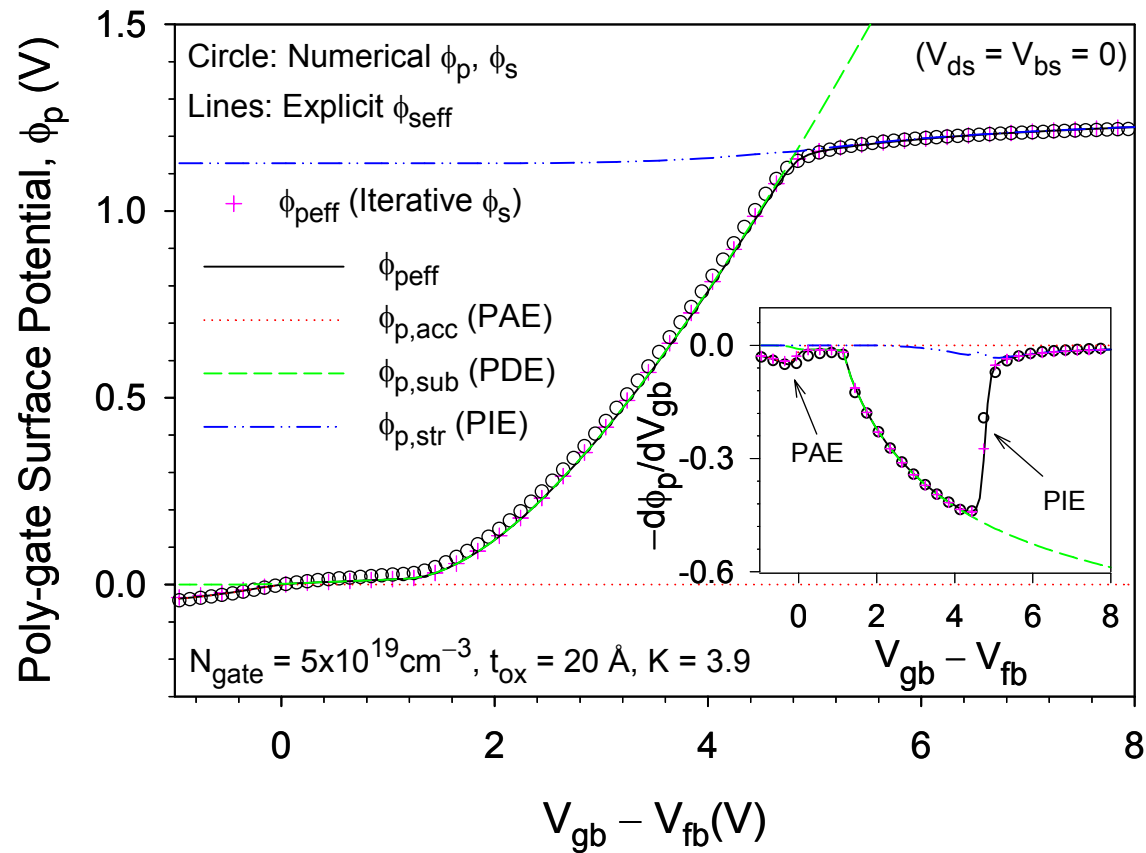
$$\phi_{p,dd} = \left(-\frac{\gamma}{2} + \sqrt{\frac{\gamma^2}{4} + V_{gb} - V_{fb} - \phi_s} \right)^2 \xrightarrow{V_{gbs} = \mathcal{G}_f \{ V_{gb} - V_{fb} - \phi_s; \rho_f \}} \boxed{\phi_{p,sub}}$$

$$\phi_{p,cc} = -v_{th} \ln \left[\frac{\gamma^2}{\gamma_p^2} \exp\left(-\frac{\phi_s}{v_{th}}\right) + \left(1 - \frac{\gamma^2}{\gamma_p^2}\right) \right] \xrightarrow{\phi_s \rightarrow \phi_{sr} = \mathcal{G}_r \{ \phi_s; \rho_r \}} \boxed{\phi_{p,acc}}$$

$$+ = \boxed{\phi_{pa} = \phi_{p,acc} + \phi_{p,sub}}$$

$$\phi_{peff} = \mathcal{G}_{eff} \{ \phi_{pa}, \phi_{p,str}; \delta_\rho \}$$

Unified Regional Poly-gate Surface Potential

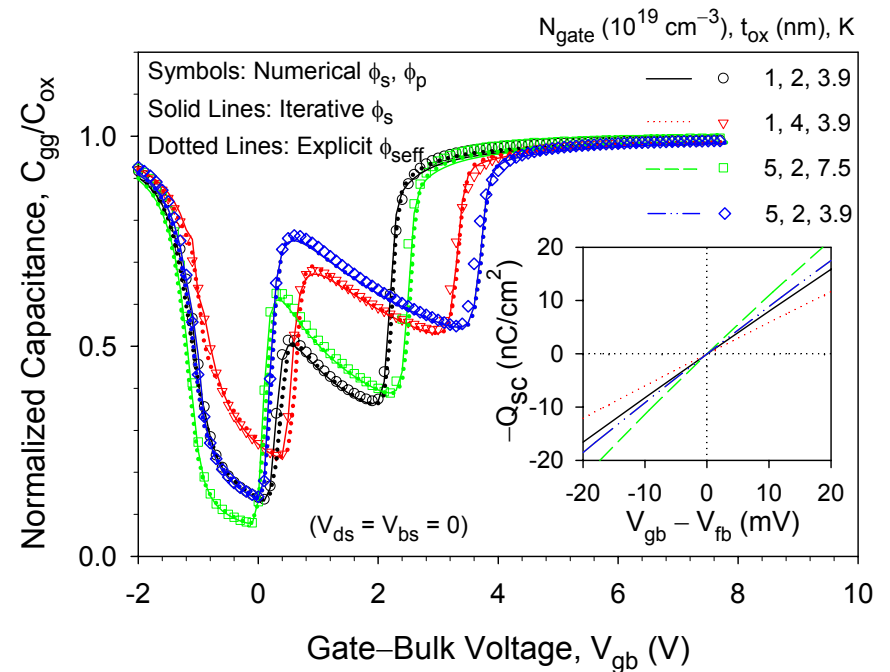
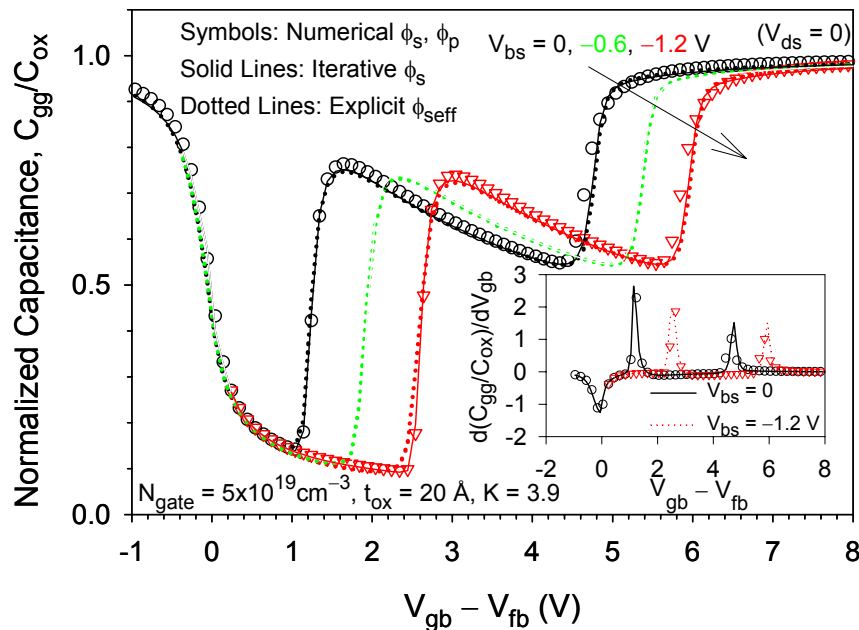


[To appear in ***Appl. Phys. Lett.***, vol. 86, no. 20, 16 May 2005.]

Poly-Accumulation/Depletion/Inversion Effects

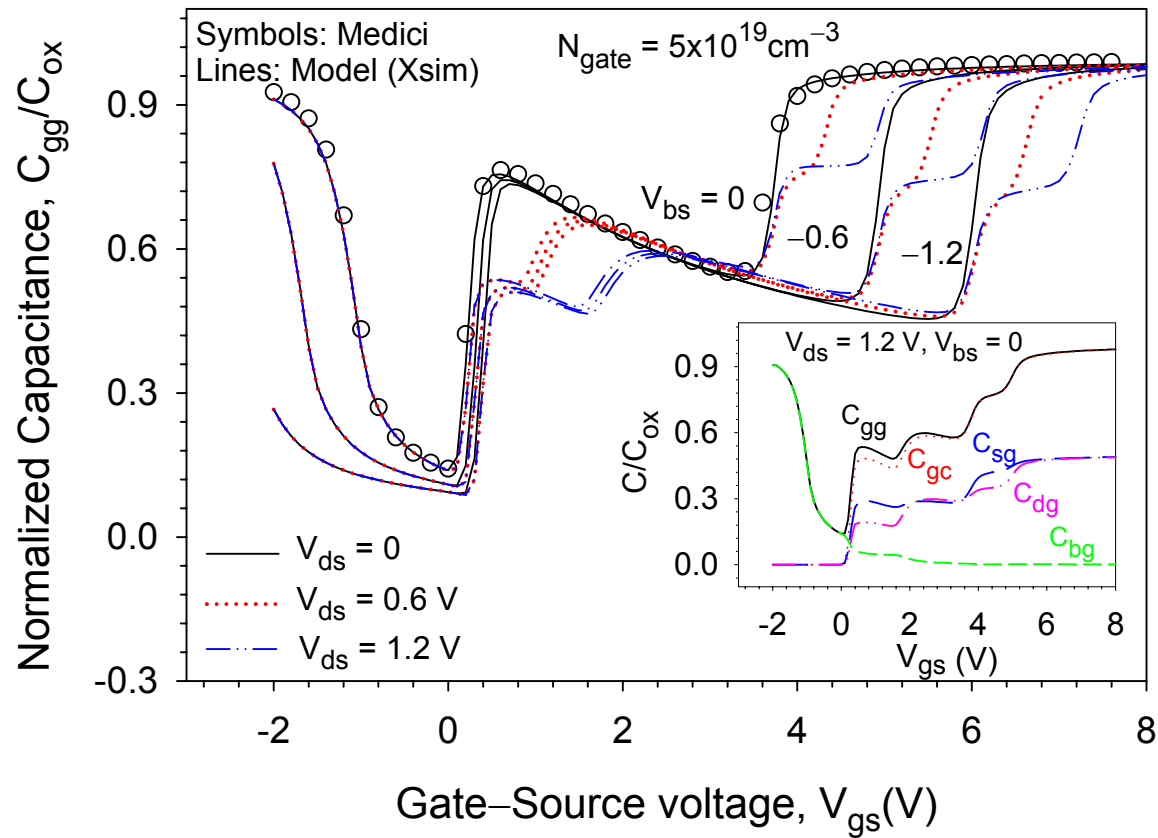
Smooth bias-scalable

Physical $N_{\text{gate}}/t_{\text{ox}}/K$ -scalable



[To appear in *Appl. Phys. Lett.*, vol. 86, no. 20, 16 May 2005.]

Unified Charge-based PAE/PDE/PIE Capacitance Model



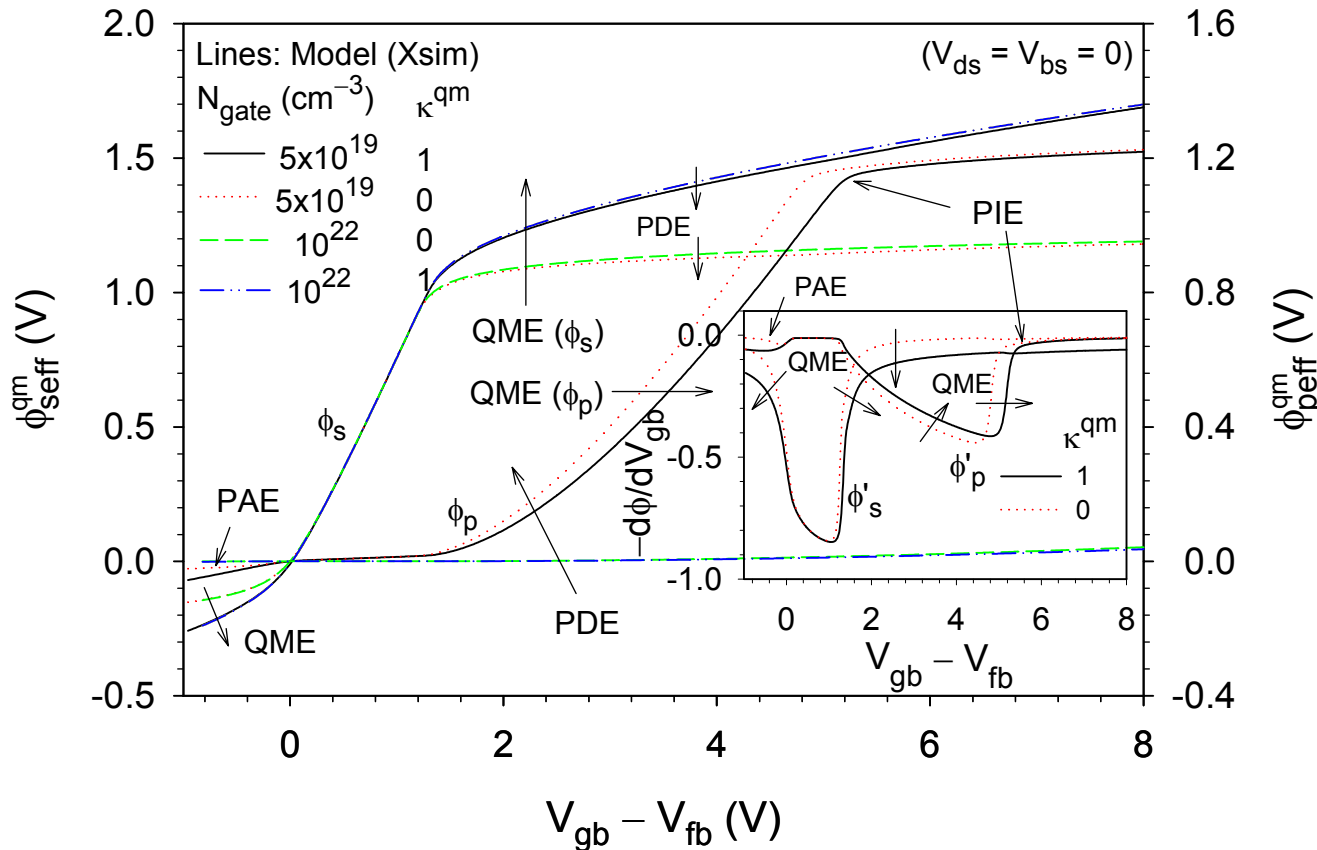
Explicit ϕ_{seff} and ϕ_{peff} with Decoupled QME and PAE/PDE

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“van Dort”:
$$\Delta E_g^{qm} \equiv E_g^{qm} - E_g = \frac{3\hbar^2}{8m^*} \left[\frac{12m^*q^2}{\epsilon_{Si}\hbar^2} \frac{2C_{ox}(V_{gb} - V_{fb} - \phi_s)/q}{3} \right]^{2/3}$$

$$n_i^{qm} = n_i \exp\left(-\Delta\phi_s^{qm}/v_{th}\right)$$



Two coupled Pao–Sah equations for ϕ_s and ϕ_p , both with:

$$\Delta\phi_s^{qm}(\phi_s) \equiv \kappa^{qm} \Delta E_g^{qm} / 2q$$

Decoupled explicit ϕ_{seff}^{qm} and ϕ_{peff}^{qm} , including QME

$$\phi_{\text{seff}}^{qm} = \phi_{\text{acc}}^{qm} + \phi_{\text{ds}}^{qm}$$

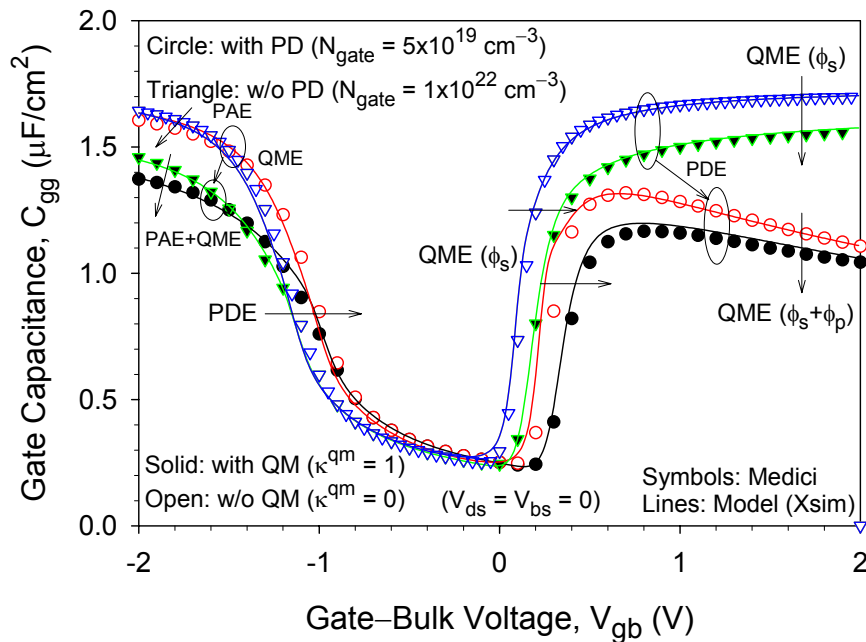
$$\phi_{\text{ds}}^{qm} = \mathcal{G}_{\text{eff}} \left\{ \phi_{\text{sub}}^{qm}, \phi_{\text{str}}^{qm}; \delta_\phi \right\}$$

$$\phi_{\text{peff}}^{qm} = \mathcal{G}_{\text{eff}} \left\{ \phi_{\text{pa}}^{qm}, \phi_{\text{p, str}}^{qm}; \delta_\rho \right\}$$

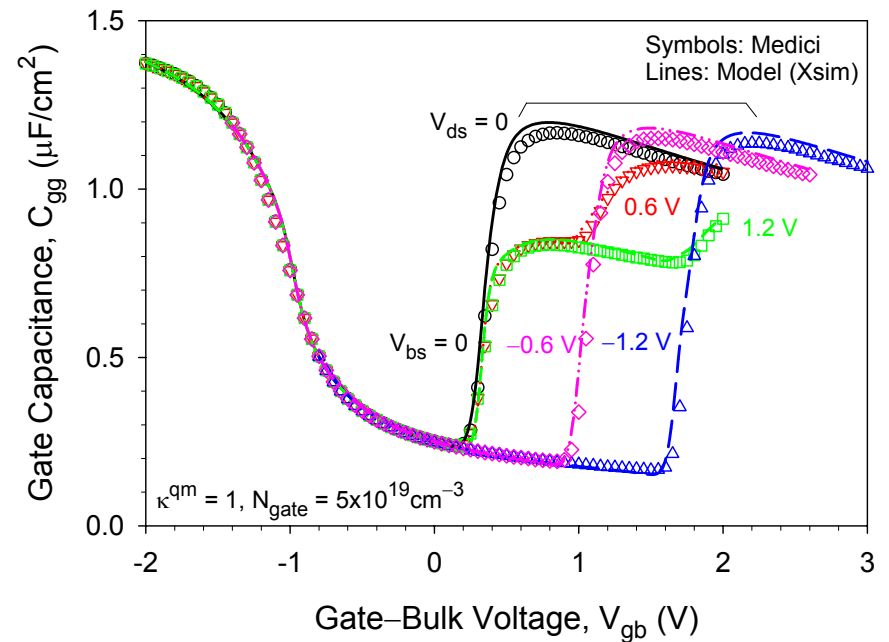
$$\phi_{\text{pa}}^{qm} = \phi_{\text{p, acc}}^{qm} + \phi_{\text{p, sub}}^{qm}$$

Bias-scalable Charge Model for Combined QME/PDE/PAE

Separate QME/PDE/PAE

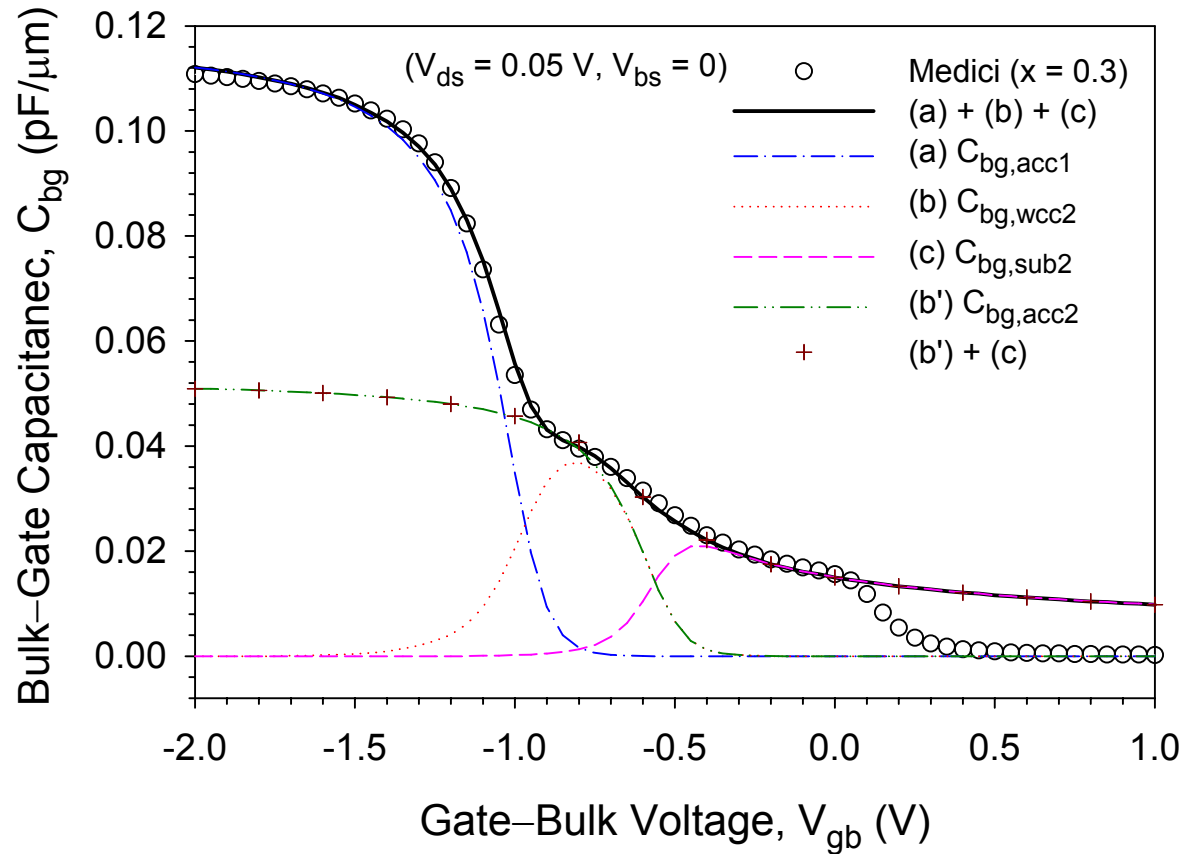


Drain/bulk-bias variation



This is believed to be the first single-piece explicit model combining all QME, PDE, PAE, PIE.

Extension to Strained-Si with Unified Regional Modeling

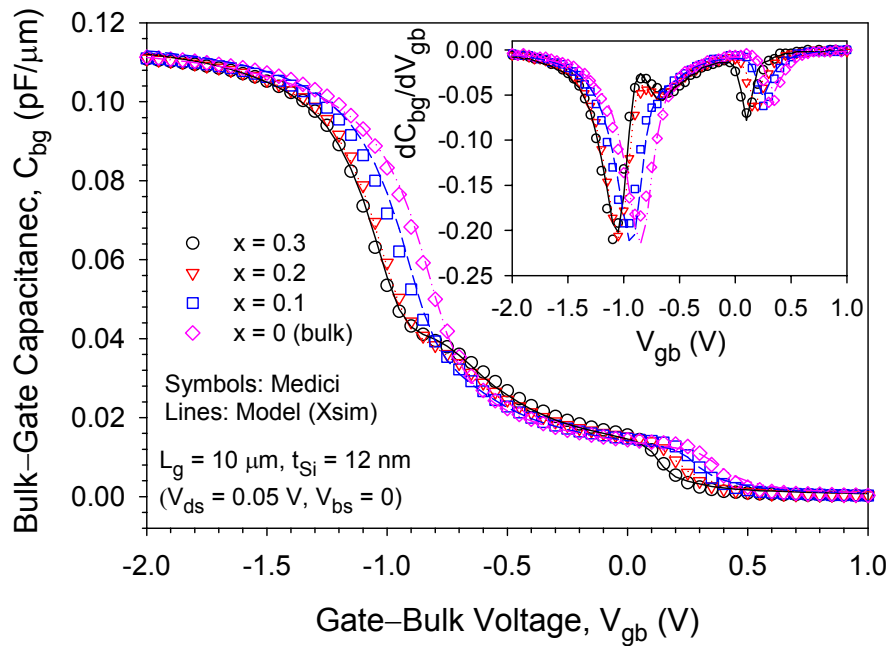


[To appear in *IEEE Trans. Electron Devices*, 2005.]

Predicting Strained-Si C_{bg} and C'_{bg}

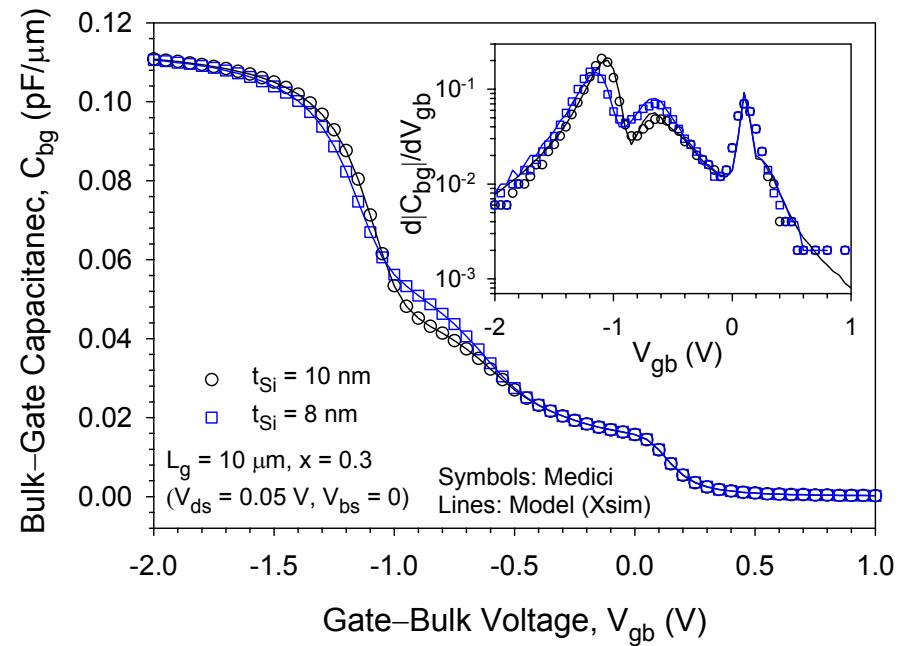
Ge mole fraction variation

($x = 0 \sim 0.3$)



s-Si thickness variation

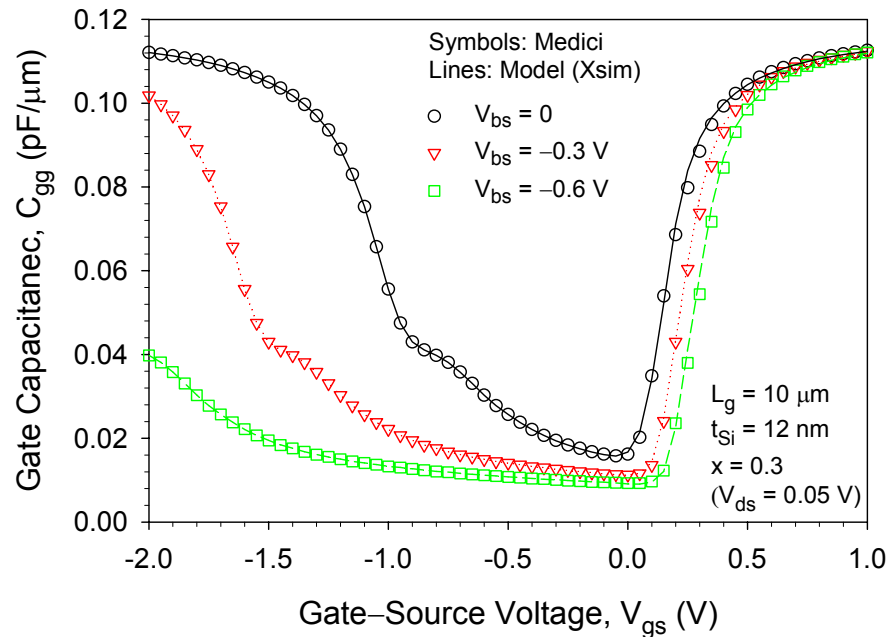
($t_{Si} = 8 \sim 10 \text{ nm}$)



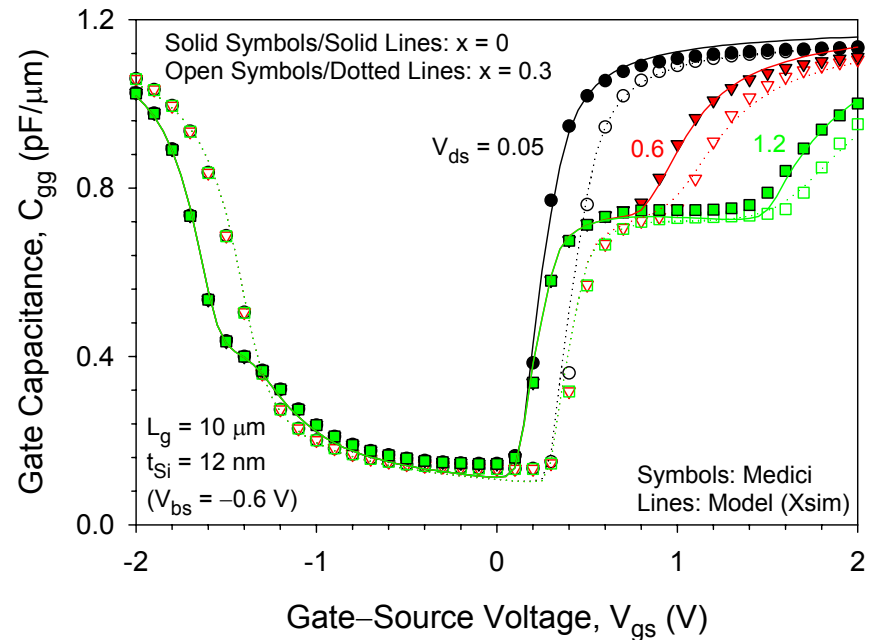
[To appear in *IEEE Trans. Electron Devices*, 2005.]

Predicting Strained-Si C_{gg}

Bulk-bias variation



Drain-bias variation

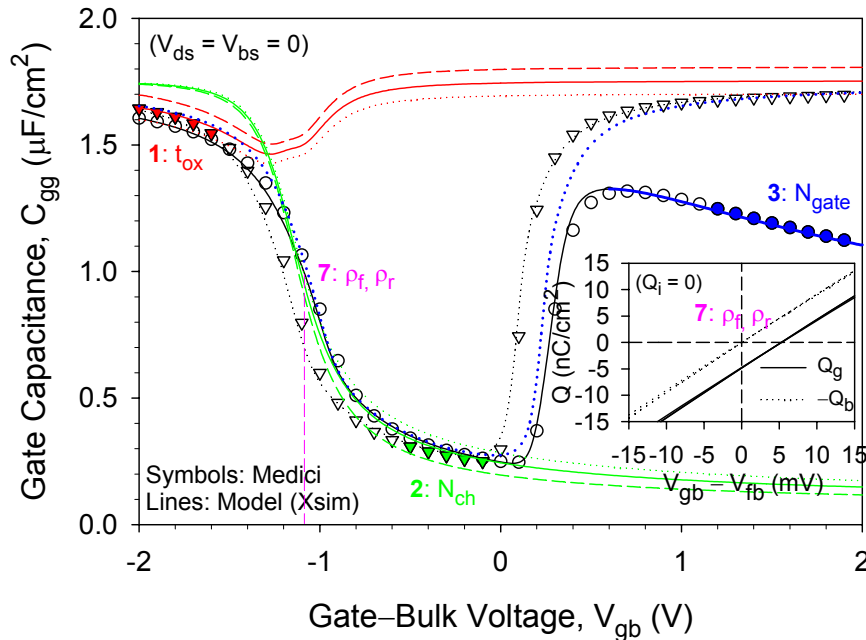


[To appear in *IEEE Trans. Electron Devices*, 2005.]

One-iteration AC Parameter Extraction

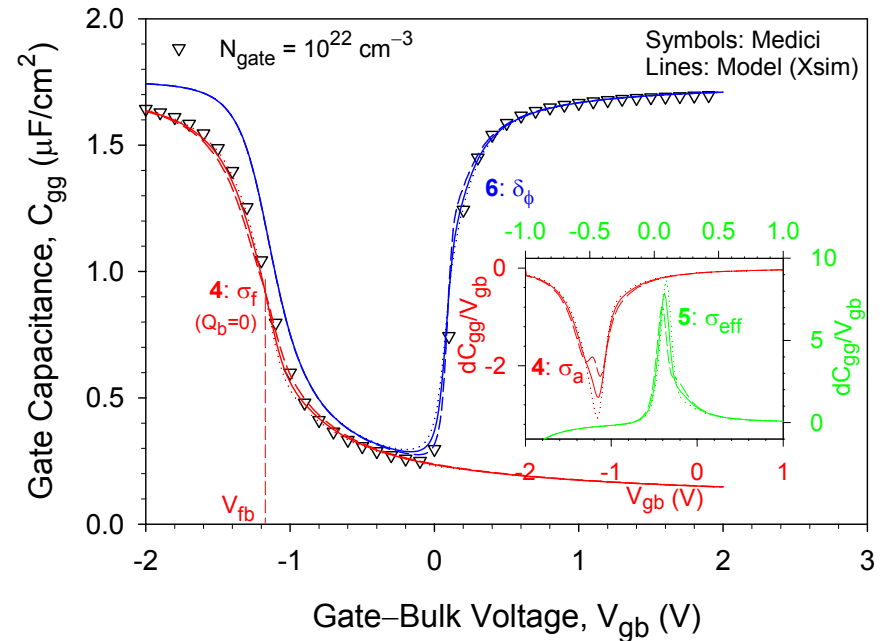
Physical parameters

$(t_{ox}, N_{ch}, N_{gate})$



Smoothing parameters

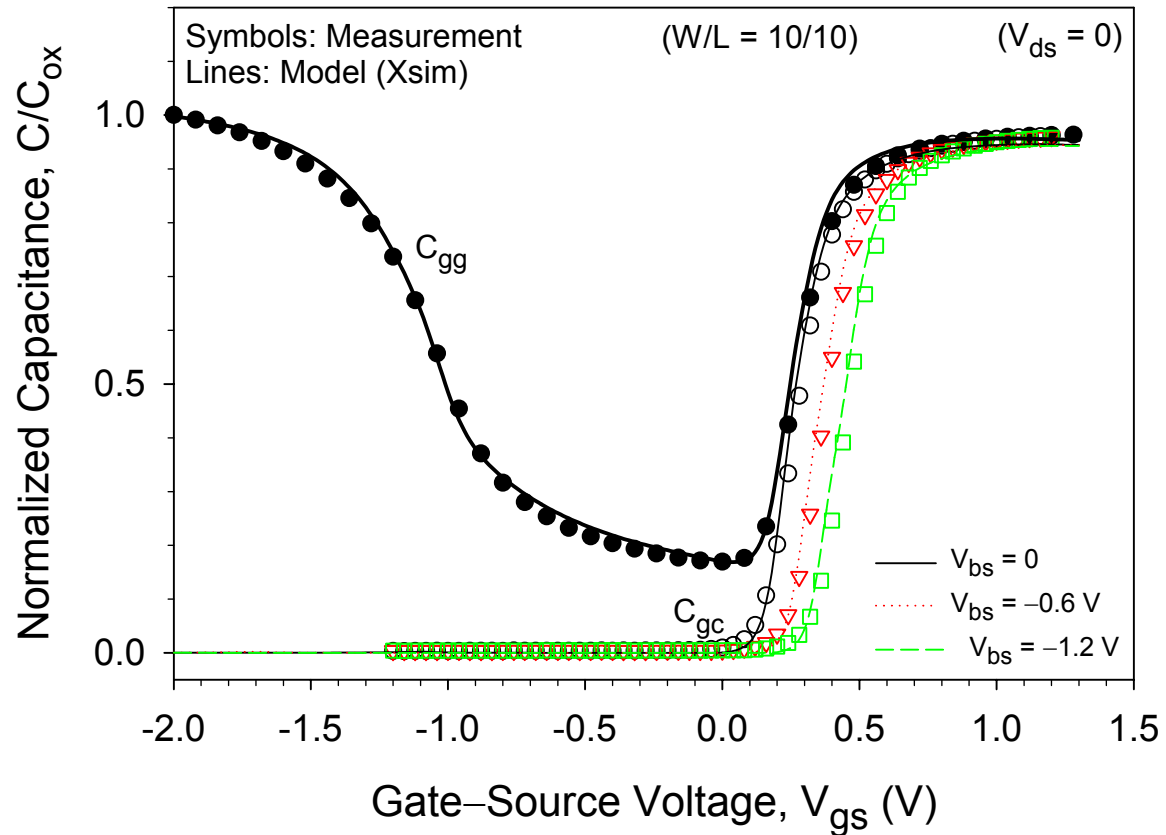
$(\sigma_a, \sigma_f; \sigma_{eff}, \delta_\phi; \rho_f, \rho_r)$



One C_{gg} data for *physical* parameter extraction. *Smoothing* parameters are determined by model requirements.

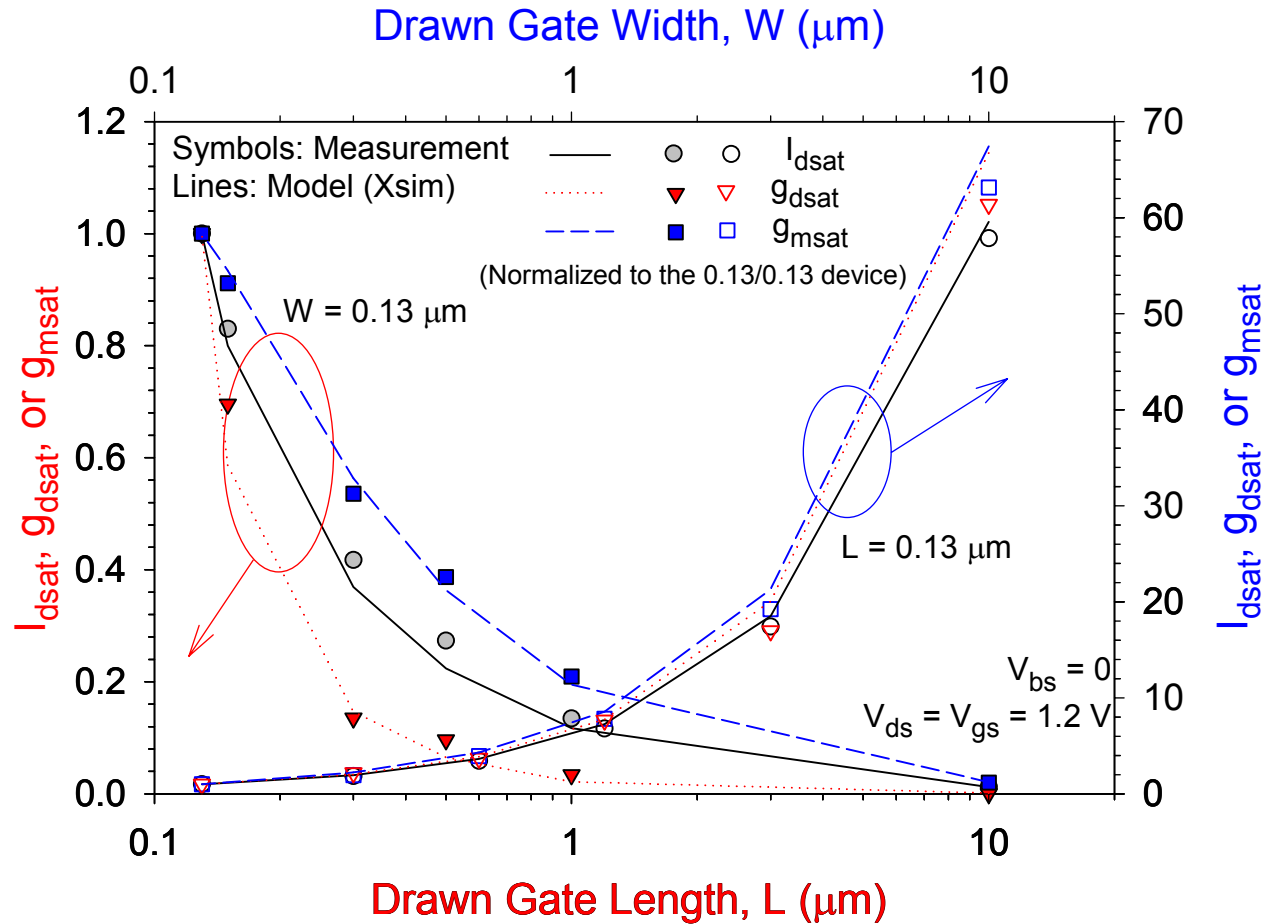
[See details in **WCM2005**, poster presentation by S. B. Chiah.]

Extracted Model from One Measured C_{gg} Data



[See details in **WCM2005**, poster presentation by S. B. Chiah.]

Predicted I_{dsat} , g_{dsat} , g_{msat} Over Geometries



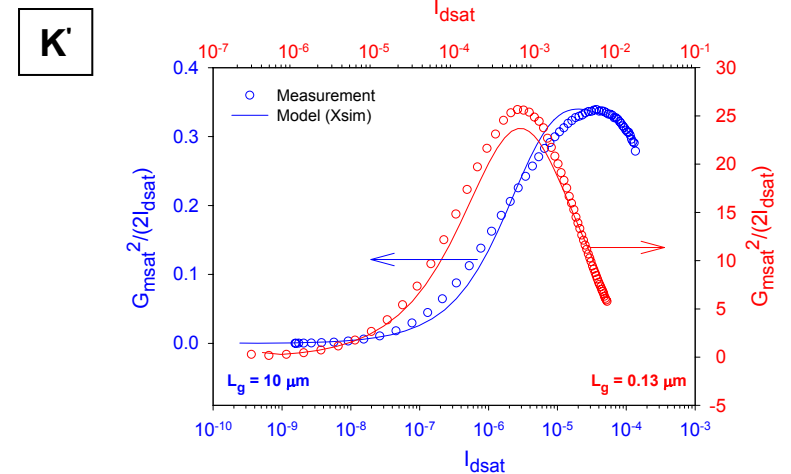
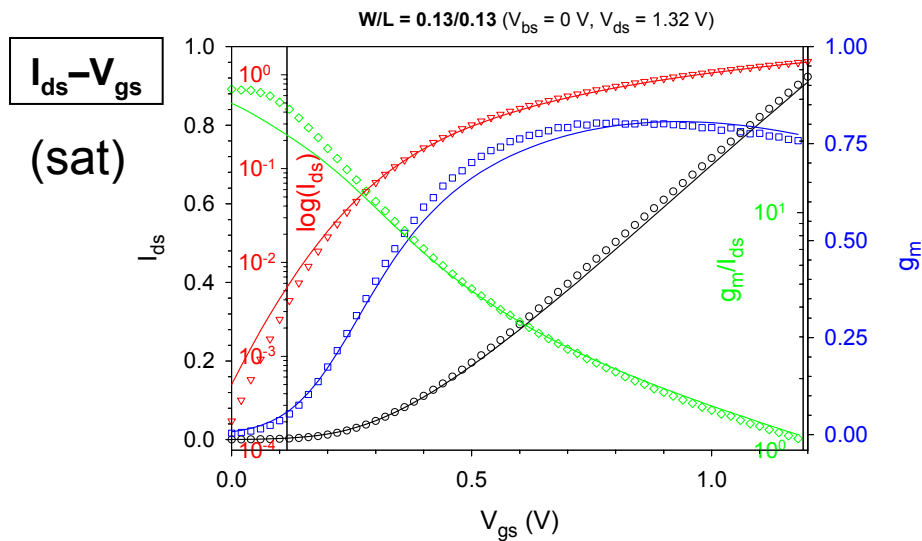
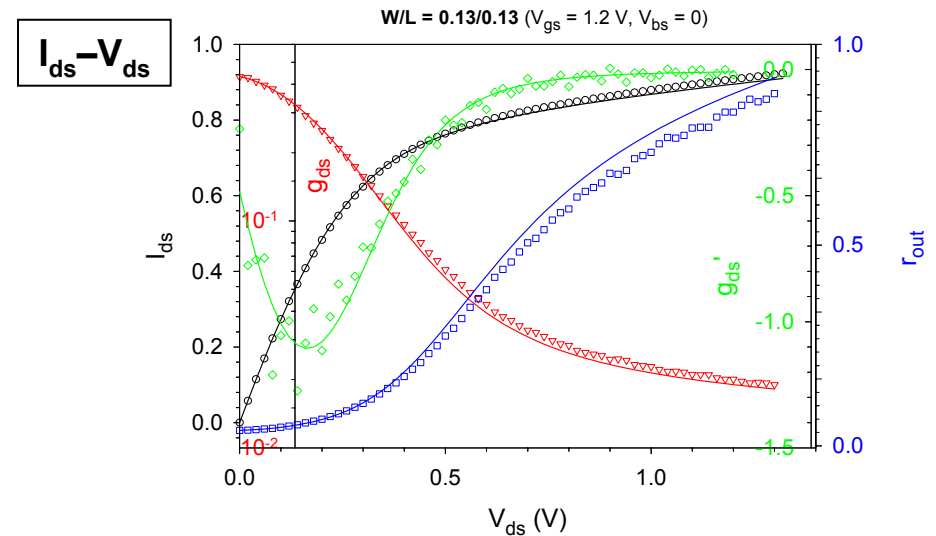
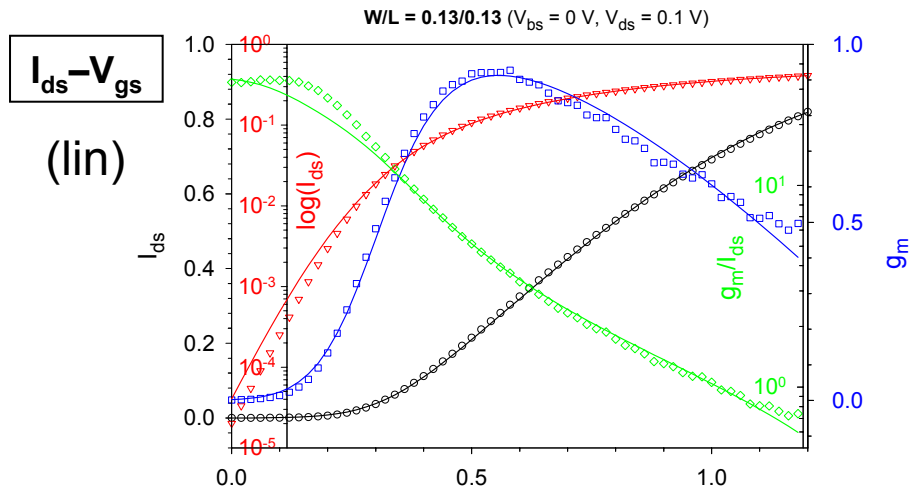
- Minimum data for model calibration:
 - $V_t - L, W$ @ corner biases
 - Point I_{dsat}, g_{ds0} data
 - Only **6** $I - V$ data
- One-iteration model extraction
 - Step-by-step
 - Second iteration for improvement
- Prediction over the entire geometry and bias, including higher-order derivatives

[See details in **WCM2005**, poster presentation by S. B. Chiah.]

Short/Narrow Device DC and Gain-Factor Prediction

WCM 2005

MSM / Nanotech



Summary and Conclusions

- ❑ **Regional charge-based approach with non-pinned surface potential** — combines the best features of $\phi_s/Q_i/V_t$ -based approaches
- ❑ **Coupled explicit solution with QME and PAE/PDE/PIE** — built into the regional Pao–Sah solutions
- ❑ **Easy extension to future MOS structures** — strained-Si (FD/PD-SOI, DG)
- ❑ **Minimum data with one/two-iteration extraction** — scalable & predictive
- ❑ **Simple and familiar formulation with selectable accuracy** — trade-off accuracy/speed within one parameter set
- ❑ **Concluding remark:** all the above combined features may be challenging to achieve with one particular (ϕ_s, Q_i, V_t) approach. Our approach and effort provide another option towards the development of next generation compact models for circuit simulation.

Acknowledgment and References

□ This work was supported in part by

- **Semiconductor Research Corporation**: Contract No. 2004-VJ-1166
- **Nanyang Technological University**: Grant RGM30/03

□ Recent publications

- “A compact gate-current model based on transfer matrix method,” to appear in **J. Appl. Phys.**, Vol. 97, No. 11, 1 June 2005.
- “Physics-based single-piece charge model for strained-Si MOSFETs,” to appear in **IEEE Trans. Electron Devices**, 2005.
- “Single-piece polycrystalline silicon accumulation/depletion/inversion model with implicit/explicit surface-potential solutions,” to appear in **Appl. Phys. Lett.**, Vol. 86, No. 20, 16 May 2005.
- “A compact model for future generation predictive technology modeling and circuit simulation,” (**Invited Paper**), to be presented at the **MIXDES 2005**, Kraków, Poland, June 23, 2005.
- “Unified regional charge model with non-pinned surface potential,” (**Invited Paper**), **Proc. IWCM-2005**, pp. 13–17, presented at the **ASP-DAC2005**, Shanghai, Jan. 20, 2005.
- “Xsim: unified regional approach to compact modeling for next generation CMOS,” (**Invited Paper**), **Proc. ICSICT-2004**, pp. 924–929, Beijing, Oct. 19, 2004.